## **Micro-stepping Motor Driver**

### INTRODUCTION

The AMIS-30623 is a single-chip micro-stepping motordriver with position controller and control/diagnostic interface. It is ready to build dedicated mechatronics solutions connected remotely with a LIN master.

The chip receives positioning instructions through the bus and subsequently drives the motor coils to the desired position. The on-chip position controller is configurable (OTP or RAM) for different motor types, positioning ranges and parameters for speed, acceleration and deceleration. The AMIS-30623 acts as a slave on the LIN bus and the master can fetch specific status information like actual position, error flags, etc. from each individual slave node.

An integrated sensor-less step-loss detection prevents the positioner from loosing steps and stops the motor when running into stall. This enables silent, yet accurate position calibrations during a referencing run and allows semi-closed loop operation when approaching the mechanical end-stops.

The chip is implemented in I2T100 technology, enabling both high voltage analog circuitry and digital functionality on the same chip. The AMIS–30623 is fully compatible with the automotive voltage requirements.

#### PRODUCT FEATURES Motordriver

- Micro-stepping Technology
- Sensorless Step-loss Detection
- Peak Current up to 800 mA
- Fixed Frequency PWM Current-control
- Automatic Selection of Fast and Slow Decay Mode
- No external Fly–back Diodes Required
- Compliant with 14 V Automotive Systems and Industrial Systems up to 24 V
- Motion Qualification Mode (Note 1)

### **Controller with RAM and OTP Memory**

- Position Controller
- Configurable Speeds and Acceleration
- Input to Connect Optional Motion Switch

### LIN Interface

- Physical Layer Compliant to LIN rev. 2.0. Data–link Layer Compatible with LIN rev. 1.3 (Note 2)
- Field–programmable Node Addresses
- Dynamically Allocated Identifiers
- Diagnostics and Status Information

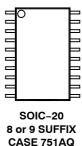
### Protection

- Overcurrent Protection
- Undervoltage Management



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NQFP-32 A or B SUFFIX CASE 560AA

### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

- Open-circuit Detection
- High Temperature Warning and Management
- Low Temperature Flag
- LIN Bus Short-circuit Protection to Supply and Ground
- Lost LIN Safe Operation

### **Power Saving**

- Powerdown Supply Current < 100 μA
- 5 V Regulator with Wake-up On LIN Activity

### **EMI Compatibility**

- LIN Bus Integrated Slope Control
- HV Outputs with Slope Control

### Patents

- US 7,271,993
- US 7,288,956
- This is a Pb-Free Device

1. Not applicable for "Product Versions AMIS30623C6238(R)G, AMIS30623C623B(R)G"

2. Minor exceptions to the conformance of the data-link layer to LIN rev. 1.3.



### APPLICATIONS

The AMIS-30623 is ideally suited for small positioning applications. Target markets include: automotive (headlamp alignment, HVAC, idle control, cruise control), industrial equipment (lighting, fluid control, labeling, process control, XYZ tables, robots...) and building automation (HVAC,

**Table 1. ORDERING INFORMATION** 

surveillance, satellite dish, renewable energy systems). Suitable applications typically have multiple axes or require mechatronics solutions with the driver chip mounted directly on the motor.

Part No.	Peak Current	End Market/Version	Package*	Shipping <sup>†</sup>
AMIS30623C6239G	800 mA		SOIC-20 (Pb-Free)	Tube/Tray
AMIS30623C6239RG	800 mA	Industrial	SOIC-20 (Pb-Free)	Tape & Reel
AMIS30623C623AG	800 mA	High Voltage Version	NQFP-32 (7 x 7 mm) (Pb-Free)	Tube/Tray
AMIS30623C623ARG	800 mA		NQFP-32 (7 x 7 mm) (Pb-Free)	Tape & Reel
AMIS30623C6238G	800 mA		SOIC-20 (Pb-Free)	Tube/Tray
AMIS30623C6238RG	800 mA	Automotive	SOIC-20 (Pb-Free)	Tape & Reel
AMIS30623C623BG	800 mA	High Temperature Version	NQFP-32 (7 x 7 mm) (Pb-Free)	Tube/Tray
AMIS30623C623BRG	800 mA	1	NQFP-32 (7 x 7 mm) (Pb-Free)	Tape & Reel

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

### QUICK REFERENCE DATA

#### **Table 2. ABSOLUTE MAXIMUM RATINGS**

	Parameter	Min	Max	Unit
V <sub>BB</sub> , VHW2, VSWI	Supply voltage, hardwired address and SWI pins	-0.3	+40 (Note 3)	V
Vlin	Bus input voltage	-40	+40	V
TJ	Junction temperature range (Note 4)	-50	+175	°C
Tst	Storage temperature	-55	+160	°C
Vesd (Note 5)	HBM Electrostatic discharge voltage on LIN pin	-4	+4	kV
	HBM Electrostatic discharge voltage on other pins (Note 6)	-2	+2	kV
	MM Electrostatic discharge voltage on other pins (Note 7)	-200	+200	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

### **Table 3. OPERATING RANGES**

	Parameter	Min	Max	Unit
V <sub>BB</sub>	Supply voltage	+6.5	+29	V
TJ	Operating temperature range	-40	+165	°C

3. For limited time: V<sub>BB</sub> <0.5 s, SWI and HW2 pins <1.0 s.

The circuit functionality is not guaranteed.
 HBM according to AEC-Q100: EIA-JESD22-A114-B (100 pF via 1.5 kΩ) and MM according to AEC-Q100: EIA-JESD22-A115-A.

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6. Tested on AMIS30623C6238(R)G version.

7. Tested on AMIS30623C623B(R)G version.

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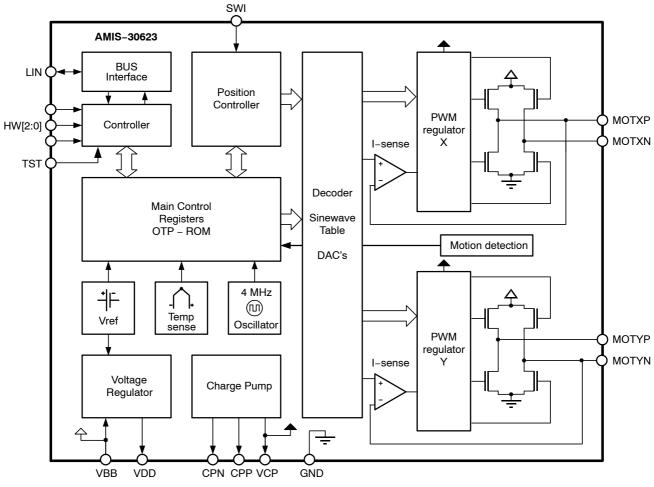


Figure 1. Block Diagram

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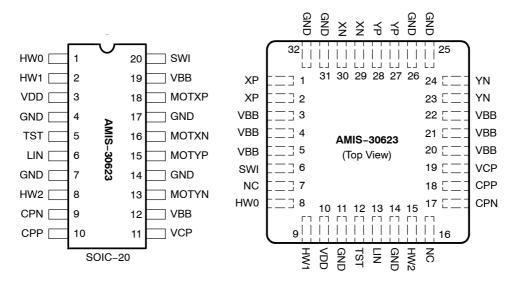


Figure 2. SOIC-20 and NQFP-32 Pin-out

Pin Name	Pin Description		SOIC-20	NQFP-32
HW0	Bit 0 of LIN-ADD		1	8
HW1	Bit 1 of LIN-ADD	To be tied to GND or V <sub>DD</sub>	2	9
VDD	Internal supply (needs external decoupling ca	pacitor)	3	10
GND	Ground, heat sink	4, 7, 14, 17	11, 14, 25, 26, 31, 32	
TST	Test pin (to be tied to ground in normal operat	ion)	5	12
LIN	LIN-bus connection	6	13	
HW2	Bit 2 LIN-ADD		8	15
CPN	Negative connection of pump-capacitor (char	ge pump)	9	17
CPP	Positive connection of pump-capacitor (charg	e pump)	10	18
VCP	Charge-pump filter-capacitor		11	19
V <sub>BB</sub>	Battery voltage supply		12,19	3, 4, 5, 20, 21, 22
MOTYN	Negative end of phase Y coil		13	23, 24
MOTYP	Positive end of phase Y coil		15	27, 28
MOTXN	Negative end of phase X coil		16	29, 30
MOTXP	Positive end of phase X coil		18	1, 2
SWI	Switch input		20	6
NC	Not connected (to be tied to ground)			7, 16

### Table 4. PIN DESCRIPTION

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### PACKAGE THERMAL RESISTANCE

The AMIS–30623 is available in SOIC–20 and optimized NQFP–32 packages. For cooling optimizations, the NQFP has an exposed thermal pad which has to be soldered to the PCB ground plane. The ground plane needs thermal vias to conduct the head to the bottom layer. Figures 3 and 4 give examples for good power distribution solutions.

For precise thermal cooling calculations the major thermal resistances of the devices are given. The thermal media to which the power of the devices has to be given are:

- Static environmental air (via the case)
- PCB board copper area (via the device pins and exposed pad)

The thermal resistances are presented in Table 5: DC Parameters.

The major thermal resistances of the device are the Rth from the junction to the ambient (Rthja) and the overall Rth from the junction to the leads (Rthjp).

The NQFP device is designed to provide superior thermal performance. Using an exposed die pad on the bottom surface of the package is mainly contributing to this performance. In order to take full advantage of the exposed pad, it is most important that the PCB has features to conduct heat away from the package. A thermal grounded pad with thermal vias can achieve this.

In the table below, one can find the values for the Rthja and Rthjp, simulated according to the JESD–51 norm:

Package	Rth Junction-to-Leads and Exposed Pad – Rthjp	Rth Junction-to-Leads Rthjp	Rth Junction-to-Ambient Rthja (1S0P)	Rth Junction-to-Ambient Rthja (2S2P)
SOIC-20		19	62	39
NQFP-32	0,95		60	30

The Rthja for 2S2P is simulated conform to JESD–51 as follows:

- A 4-layer printed circuit board with inner power planes and outer (top and bottom) signal layers is used
- Board thickness is 1.46 mm (FR4 PCB material)
- The 2 signal layers: 70 μm thick copper with an area of 5500 mm<sup>2</sup> copper and 20% conductivity
- The 2 power internal planes: 36 µm thick copper with an area of 5500 mm<sup>2</sup> copper and 90% conductivity

The Rthja for 1S0P is simulated conform to JESD-51 as follows:

- A 1-layer printed circuit board with only 1 layer
- Board thickness is 1.46 mm (FR4 PCB material)
- The layer has a thickness of 70 μm copper with an area of 5500 mm<sup>2</sup> copper and 20% conductivity

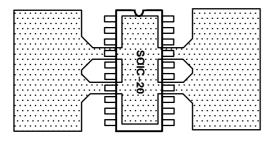


Figure 3. Example of SOIC-20 PCB Ground Plane Layout (preferred layout at top and bottom)

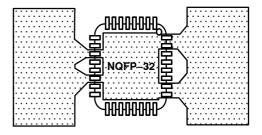


Figure 4. Example of NQFP-32 PCB Ground Plane Layout (preferred layout at top and bottom)

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### **DC PARAMETERS**

The DC parameters are guaranteed overtemperature and  $V_{BB}$  in the operating range, unless otherwise specified. Convention: currents flowing into the circuit are defined as positive.

### Table 5. DC PARAMETERS

Symbol	Pin(s)	Parameter	Test Conditions	Min	Тур	Max	Unit
MOTORDRI	VER						
I <sub>MSmax,</sub> Peak		Max current through motor coil in normal operation	V <sub>BB</sub> = 14 V		800		mA
I <sub>MSmax,RMS</sub>		Max rms current through coil in normal operation	V <sub>BB</sub> = 14 V		570		mA
I <sub>MSabs</sub>	MOTVO	Absolute error on coil current (Note 8)	V <sub>BB</sub> = 14 V	-10		10	%
I <sub>MSrel</sub>	MOTXP MOTXN MOTYP	Matching of X & Y coil currents	V <sub>BB</sub> = 14 V	-7	0	7	%
R <sub>DS(on)</sub>	MOTYN	On resistance for each	$V_{BB}$ = 12 V, $T_j$ = 50°C		0.50	1	Ω
		motor pin at I <sub>MSmax</sub> (Note 9)	$V_{BB}$ = 8 V, $T_j$ = 50°C		0.55	1	Ω
			V <sub>BB</sub> = 12 V, T <sub>j</sub> = 150°C		0.70	1	Ω
			V <sub>BB</sub> = 8 V, T <sub>j</sub> = 150°C		0.85	1	Ω
I <sub>MSL</sub>		Pulldown current	HiZ mode, V <sub>BB</sub> = 7.8 V		2		mA
LIN TRANSI	MITTER						
I <sub>bus_off</sub>		Dominant state, driver off	$V_{bus} = 0 V, V_{BB} = 8 V \& 18 V$	-1			mA
I <sub>bus_off</sub>	1	Recessive state, driver off	$V_{bus} = V_{bat}$ , $V_{BB} = 8 V \& 18 V$			20	μA
I <sub>bus_lim</sub>	LIN	Current limitation	V <sub>BB</sub> = 8 V & 18 V	50	75	130	mA
R <sub>slave</sub>		Pullup resistance	V <sub>BB</sub> = 8 V & 18 V	20	30	47	kΩ
LIN RECEIV	ER						
V <sub>bus_dom</sub>		Receiver dominant state	V <sub>BB</sub> = 8 V & 18 V	0		0.4 * V <sub>BB</sub>	V
V <sub>bus_rec</sub>	LIN	Receiver recessive state	V <sub>BB</sub> = 8 V & 18 V	0.6 * V <sub>BB</sub>		V <sub>BB</sub>	V
V <sub>bus_hys</sub>		Receiver hysteresis	V <sub>BB</sub> = 8 V & 18 V	0.05 * V <sub>BB</sub>		0.175 * V <sub>BB</sub>	V
THERMAL V	VARNING	& SHUTDOWN	•	•			
T <sub>tw</sub>		Thermal warning (Notes 10 and 11)		138	145	152	°C
T <sub>tsd</sub>		Thermal shutdown (Note 12)			T <sub>tw</sub> + 10		°C
T <sub>low</sub>		Low temperature warning (Note 12)			T <sub>tw</sub> – 155		°C
SUPPLY AN	D VOLTA	GE REGULATOR					
V <sub>bbOTP</sub>		Supply voltage for OTP zapping (Note 13)		9.0		10.0	V
UV <sub>1</sub>	1	Stop voltage high threshold		7.8	8.4	8.9	V
UV <sub>2</sub>	V	Stop voltage low threshold		7.1	7.5	8.0	V
I <sub>bat</sub>	V <sub>BB</sub>	Total current consumption	Unloaded outputs V <sub>BB</sub> = 29 V		3.50	10.0	mA
I <sub>bat_s</sub>	1	Sleep mode current consumption	V <sub>BB</sub> = 8 V & 18 V		50	100	μΑ

8. Tested in production for 800 mA, 400 mA, 200 mA and 100 mA current settings for both X and Y coil.

9. Not measured in production. Guaranteed by design.

10. Parameter guaranteed by trimming relevant OTP's in production test at 143°C ( $\pm$ 5°C) and V<sub>BB</sub> = 14 V.

11. No more than 100 cumulated hours in life time above Tw.

12. Thermal shutdown and low temperature warning are derived from thermal warning. Guaranteed by design.

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13. A buffer capacitor of minimum 100 µF is needed between V<sub>BB</sub> and GND. Short connections to the power supply are recommended.

### **Table 5. DC PARAMETERS**

Symbol	Pin(s)	Parameter	Test Conditions	Min	Тур	Мах	Unit
SUPPLY AN	ID VOLTA	GE REGULATOR					
$V_{DD}$		Regulated internal supply (Note 14)	8 V < V <sub>BB</sub> < 29 V	4.75	5	5.50	V
V <sub>ddReset</sub>	V <sub>DD</sub>	Digital supply reset level @ power down (Note 15)				4.5	V
l <sub>ddLim</sub>		Current limitation	Pin shorted to ground V <sub>BB</sub> = 14 V			45	mA
SWITCH IN		HARDWIRE ADDRESS INPU	T				
Rt_OFF		Switch OPEN resistance (Note 16)		10			kΩ
Rt_ON	SWI HW2	Switch ON resistance (Note 16)	Switch to GND or $V_{BB}$			2	kΩ
$V_{bb\_sw}$	V <sub>BB</sub> range for guaranteed operation of SWI and HW2			6		29	V
I <sub>lim_sw</sub>		Current limitation	Short to GND or V <sub>bat</sub> V <sub>BB</sub> = 29 V	20	30	45	mA
HARDWIRE	D ADDRE	SS INPUTS AND TEST PIN					
V <sub>ihigh</sub>	HW0	Input level high	V <sub>BB</sub> = 14 V	0.7 * V <sub>dd</sub>			V
V <sub>ilow</sub>	HW1	Input level low	V <sub>BB</sub> = 14 V			0.3 * V <sub>dd</sub>	V
HW <sub>hyst</sub>	TST	Hysteresis	V <sub>BB</sub> = 14 V	0.075 * V <sub>dd</sub>			V
CHARGE P	UMP						
V <sub>cp</sub>		Output voltage	$6~V \le V_{BB} \le 14~V$		2 * V <sub>BB</sub> – 2.5		V
	VCP		$14~V \leq V_{BB} \leq 30~V$	V <sub>BB</sub> + 10		V <sub>BB</sub> + 15	V
C <sub>buffer</sub>		External buffer capacitor		220		470	nF
C <sub>pump</sub>	CPP CPN	External pump capacitor		220		470	nF
MOTION QU	JALIFICAT	TION MODE OUTPUT (Note 1)	7)				
V <sub>OUT</sub>		Output voltage swing	TestBemf LIN command		0 – 4,85		V
R <sub>OUT</sub>	SWI	Output impedance	Service mode LIN command		2		kΩ
Av		Gain = V <sub>SWI</sub> / V <sub>BEMF</sub>	Service mode LIN command		0.50		
PACKAGE	THERMAL	RESISTANCE VALUES					
Rth <sub>ja</sub>	SO	Thermal resistance junction to ambient (2S2P)			39		K/W
Rth <sub>jp</sub>	SO	Thermal resistance junction to leads	Simulated conform		19		K/W
Rth <sub>ja</sub>	NQ	Thermal resistance junction to ambient (2S2P)	JEDEC JESD51		30		K/W
Rth <sub>jp</sub>	NQ	Thermal resistance junction to leads and exposed pad			0.95		K/W

14. Fin V<sub>DD</sub> must not be used for any external supply
15. The RAM content will not be altered above this voltage.
16. External resistance value seen from pin SWI or HW2, including 1 kΩ series resistor. For the switch OPEN, the maximum allowed leakage current is represented by a minimum resistance seen from the pin.
17. Not applicable for "Product Versions AMIS30623C6238(R)G, AMIS30623C623B(R)G"

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### **AC PARAMETERS**

The AC parameters are guaranteed for temperature and  $V_{BB}$  in the operating range unless otherwise specified. The LIN transmitter and receiver physical layer parameters are compliant to LIN rev. 2.0 & 2.1.

### Table 6. AC PARAMETERS

Symbol	Pin(s)	Parameter	Test Conditions	Min	Тур	Max	Unit
POWERUP							
Т <sub>ри</sub>	P       Power-up time       Guaranteed by design       10         L OSCILLATOR       Frequency of internal oscillator $V_{BB} = 14$ V       3.6       4.0       4.4         SMITTER CHARACTERISTICS ACCORDING TO LIN v2.0 & v2.1       THRec(max) = 0.744 x V_{BB}       0.396          LIN       Duty cycle 1 = t <sub>Bus</sub> ne(min) / (2 x t <sub>Bi</sub> ); See Figure 5       THRec(max) = 0.744 x V_{BB}       0.396          LIN       Duty cycle 2 = t <sub>Bus</sub> ne(max) / (2 x t <sub>Bi</sub> ); See Figure 5       THRec(max) = 0.744 x V_{BB}       0.396           LIN       Duty cycle 1 = t <sub>Bus</sub> ne(max) / (2 x t <sub>Bi</sub> ); See Figure 5       THRec(mina) = 0.284 x V_{BB}       0.581          VER CHARACTERISTICS ACCORDING TO LIN v2.0 & v2.1       THRec(min) = 0.284 x V_{BB}        0.581          VER CHARACTERISTICS ACCORDING TO LIN v2.0 & v2.1       THRec(min) = 0.284 x V_{BB}        0.581          VER CHARACTERISTICS ACCORDING TO LIN v2.0 & v2.1       THRec(min) = 0.284 x V_{BB}        0.581        0.581         VER CHARACTERISTICS ACCORDING TO LIN v2.0 & v2.1       Three trace of us to the the to th		ms				
NTERNAL O	SCILLATO	R					
f <sub>osc</sub>		Frequency of internal oscillator	V <sub>BB</sub> = 14 V	3.6	4.0	4.4	MHz
IN TRANSM	TTER CH	ARACTERISTICS ACCORDING TO	LIN v2.0 & v2.1				-
D1		Duty cycle 1 = t <sub>Bus_rec(min)</sub> / (2 x t <sub>Bit</sub> ); See Figure 5	THDom(max) = 0.581 x V <sub>BB</sub> ; V <sub>BB</sub> = 7.0 V18 V;	0.396			
D2		Duty cycle 2 = t <sub>Bus_rec(max)</sub> / (2 x t <sub>Bit</sub> ); See Figure 5	THDom(min) = 0.422 x $V_{BB}$ ; V <sub>BB</sub> = 7.6 V18 V;			0.581	
LIN RECEIVE	R CHARA	CTERISTICS ACCORDING TO LIN	v2.0 & v2.1				
trx_pdr			V <sub>BB</sub> = 7.0 V & 18 V; See Figure 5			6	μs
trx_pdf	LIN					6	μs
trx_sym		, , ,	trx_pdr – trx_pdf	-2		+2	μs
SWITCH INPL	JT AND H	ARDWIRE ADDRESS INPUT					
T <sub>sw</sub>	0)4//	Scan pulse period (Note 18)	V <sub>BB</sub> = 14 V		1024		μs
T <sub>sw_on</sub>			V <sub>BB</sub> = 14 V		128		μs
MOTORDRIV	ER						
F <sub>pwm</sub>		PWM frequency (Note 18)	PWMfreq = 0 (Note 19)	20.6	22.8	25.0	kHz
			PWMfreq = 1 (Note 19)	41.2	45.6	50.0	kHz
F <sub>jit_depth</sub>		PWM jitter modulation depth	PWMJen = 1 (Note 19)		10		%
T <sub>brise</sub>	MOTxx	Turn-on transient time	Between 10% and 90%		140		ns
T <sub>bfall</sub>		Turn-off transient time			130		ns
T <sub>stab</sub>				29	32	35	ms
CHARGE PUI	MP						
f <sub>CP</sub>	CPN CPP	Charge pump frequency (Note 18)	V <sub>BB</sub> = 14 V		250		kHz

18. Derived from the internal oscillator

19. See <u>SetMotorParam</u> and <u>PWM Regulator</u>

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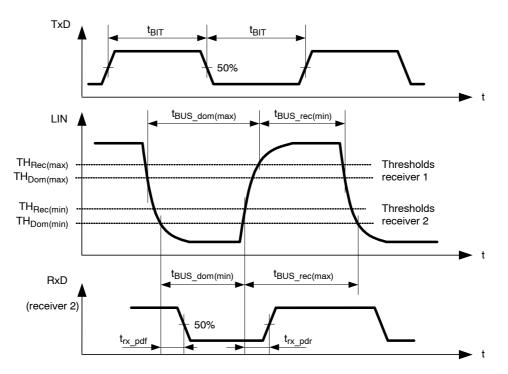


Figure 5. Timing Diagram for AC Characteristics According to LIN 2.0 & 2.1

**Typical Application** 

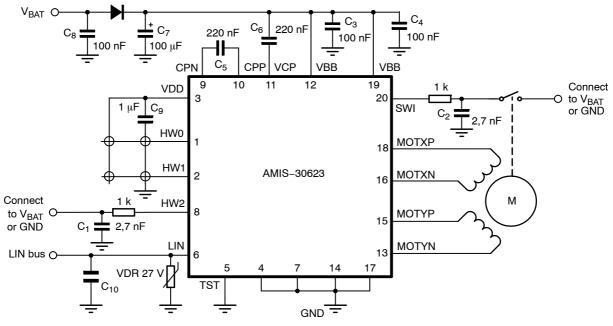


Figure 6. Typical Application Diagram for SO Device

NOTES: All resistors are  $\pm\,5\%,\,1/4$  W

 $C_1$ ,  $C_2$  minimum value is 2.7 nF, maximum value is 10 nF

Depending on the application, the ESR value and working voltage of C<sub>7</sub> must be carefully chosen C<sub>3</sub> and C<sub>4</sub> must be close to pins V<sub>BB</sub> and GND

 $C_5$  and  $C_6$  must be as close as possible to pins CPN, CPP, VCP, and  $V_{BB}$  to reduce EMC radiation  $C_9$  must be a ceramic capacitor to assure low ESR

C<sub>10</sub> is placed for EMC reasons; value depends on EMC requirements of the application

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### **POSITIONING PARAMETERS**

### **Stepping Modes**

One of four possible stepping modes can be programmed:

- Half-stepping
- 1/4 micro-stepping
- 1/8 micro-stepping
- 1/16 micro-stepping

### **Maximum Velocity**

For each stepping mode, the maximum velocity Vmax can be programmed to 16 possible values given in the table below.

The accuracy of Vmax is derived from the internal oscillator. Under special circumstances it is possible to change the Vmax parameter while a motion is ongoing. All 16 entries for the Vmax parameter are divided into four groups. When changing Vmax during a motion the application must take care that the new Vmax parameter stays within the same group.

Vmax	Index				Stepping	Mode	
Hex	Dec	Vmax (full step/s)	Group	Half–stepping (half–step/s)	1/4 <sup>th</sup> Micro–stepping (micro–step/s)	1/8 <sup>th</sup> Micro–stepping (micro–step/s)	1/16 <sup>th</sup> Micro-stepping (micro-step/s)
0	0	99	А	197	395	790	1579
1	1	136		273	546	1091	2182
2	2	167		334	668	1335	2670
3	3	197	В	395	790	1579	3159
4	4	213	Б	425	851	1701	3403
5	5	228		456	912	1823	3647
6	6	243		486	973	1945	3891
7	7	273		546	1091	2182	4364
8	8	303		607	1213	2426	4852
9	9	334	с	668	1335	2670	5341
А	10	364	C	729	1457	2914	5829
В	11	395		790	1579	3159	6317
С	12	456		912	1823	3647	7294
D	13	546		1091	2182	4364	8728
E	14	729	D	1457	2914	5829	11658
F	15	973		1945	3891	7782	15564

### Table 7. MAXIMUM VELOCITY SELECTION TABLE

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### **Minimum Velocity**

Once the maximum velocity is chosen, 16 possible values can be programmed for the minimum velocity Vmin. The table below provides the obtainable values in full-step/s. The accuracy of Vmin is derived from the internal oscillator.

									Vn	nax (Fu	ll-step	/s)						
Vmin	Index	Vmax	Α			E	3					C	)			D		
Hex	Dec	Factor	99	136	167	197	213	228	243	273	303	334	364	395	456	546	729	973
0	0	1	99	136	167	197	213	228	243	273	303	334	364	395	456	546	729	973
1	1	1/32	3	4	5	6	6	7	7	8	8	10	10	11	13	15	19	27
2	2	2/32	6	8	10	11	12	13	14	15	17	19	21	23	27	31	42	57
3	3	3/32	9	12	15	18	19	21	22	25	27	31	32	36	42	50	65	88
4	4	4/32	12	16	20	24	26	28	30	32	36	40	44	48	55	65	88	118
5	5	5/32	15	21	26	31	32	35	37	42	46	51	55	61	71	84	111	149
6	6	6/32	18	25	31	36	39	42	45	50	55	61	67	72	84	99	134	179
7	7	7/32	21	30	36	43	46	50	52	59	65	72	78	86	99	118	156	210
8	8	8/32	24	33	41	49	52	56	60	67	74	82	90	97	113	134	179	240
9	9	9/32	28	38	47	55	59	64	68	76	84	93	101	111	128	153	202	271
А	10	10/32	31	42	51	61	66	71	75	84	93	103	113	122	141	168	225	301
В	11	11/32	34	47	57	68	72	78	83	93	103	114	124	135	156	187	248	332
С	12	12/32	37	51	62	73	79	85	91	101	113	124	135	147	170	202	271	362
D	13	13/32	40	55	68	80	86	93	98	111	122	135	147	160	185	221	294	393
Е	14	14/32	43	59	72	86	93	99	106	118	132	145	158	172	198	237	317	423
F	15	15/32	46	64	78	93	99	107	113	128	141	156	170	185	214	256	340	454

Table 8.	<b>OBTAINABLE</b>	VALUES IN FULL	-STEP/s FOR	THE MINIMUM VEL	OCITY
Tuble 0.	ODIAMADLE	ALOLO IN I OLL			

NOTES: The Vmax factor is an approximation.

In case of motion without acceleration (AccShape = 1) the length of the steps = 1/Vmin. In case of accelerated motion (AccShape = 0) the length of the first step is shorter than 1/Vmin depending of Vmin, Vmax and Acc.

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### Acceleration and Deceleration

Sixteen possible values can be programmed for Acc (acceleration and deceleration between Vmin and Vmax). The table below provides the obtainable values in full–step/ $s^2$ . One observes restrictions for some

combinations of acceleration index and maximum speed (gray cells).

The accuracy of Acc is derived from the internal oscillator.

### Table 9. ACCELERATION AND DECELERATION SELECTION TABLE

	Vmax (FS/s) →	99	136	167	197	213	228	243	273	303	334	364	395	456	546	729	973
↓ Aco	c Index																
Hex	Dec		Acceleration (Full-step/s <sup>2</sup> )														
0	0		49 106							473							
1	1		218							735							
2	2									1004							
3	3		3609														
4	4		6228														
5	5		8848														
6	6		11409														
7	7									13970							
8	8									16531							
9	9									19092							
А	10									21886							
В	11									24447							
С	12	14785	27008														
D	13			29570													
E	14				201	-70				34925							
F	15				29:	570				40047							

The formula to compute the number of equivalent full-steps during acceleration phase is:

$$Nstep = \frac{Vmax^2 - Vmin^2}{2 \times Acc}$$

#### Positioning

The position programmed in commands <u>SetPosition</u> and <u>SetPositionShort</u> is given as a number of (micro-)steps. According to the chosen stepping mode, the position words must be aligned as described in the table below. When using command <u>SetPositionShort</u> or <u>GotoSecurePosition</u>, data is automatically aligned.

### Table 10. POSITION WORD ALIGNMENT

Stepping Mode		Position Word: Pos[15:0]										Shift					
1/16 <sup>th</sup>	S	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	LSB	No shift
1/8 <sup>th</sup>	S	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	LSB	0	1–bit left ⇔×2
1/4 <sup>th</sup>	S	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	LSB	0	0	2–bit left ⇔ ×4
Half-stepping	s	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	LSB	0	0	0	3–bit left ⇔×8
PositionShort	s	S	S	B9	B8	B7	B6	B5	B4	B3	B2	B1	LSB	0	0	0	No shift
SecurePosition	S	B9	B8	B7	B6	B5	B4	B3	B2	B1	LSB	0	0	0	0	0	No shift

NOTES: LSB: Least Significant Bit

S: Sign bit

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### **Position Ranges**

A position is coded by using the binary two's complement format. According to the positioning commands used and to the chosen stepping mode, the position range will be as shown in the following table.

Command	Stepping Mode	Position Range	Full Range Excursion	Number of Bits
	Half-stepping	-4096 to +4095	8192 half-steps	13
	1/4 <sup>th</sup> micro-stepping	-8192 to +8191	16384 micro-steps	14
SetPosition	1/8 <sup>th</sup> micro-stepping	-16384 to +16383	32768 micro-steps	15
	1/16 <sup>th</sup> micro-stepping	-32768 to +32767	65536 micro-steps	16
SetPositionShort	Half-stepping	-1024 to +1023	2048 half-steps	11

### Table 11. POSITION RANGE

When using the command <u>SetPosition</u>, although coded on 16 bits, the position word will have to be shifted to the left by a certain number of bits, according to the stepping mode.

#### **Secure Position**

A secure position can be programmed. It is coded in 11-bits, thus having a lower resolution than normal positions, as shown in the following table. See also command <u>GotoSecurePosition</u> and <u>LIN lost behavior</u>.

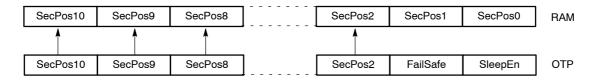
### Table 12. SECURE POSITION

Stepping Mode	Secure Position Resolution				
Half-stepping	4 half-steps				
1/4 <sup>th</sup> micro-stepping	8 micro-steps (1/4 <sup>th</sup> )				
1/8 <sup>th</sup> micro-stepping	16 micro-steps (1/8 <sup>th</sup> )				
1/16 <sup>th</sup> micro-stepping	32 micro-steps (1/16 <sup>th</sup> )				

### Important

NOTES: The secure position is disabled in case the programmed value is the reserved code "1000000000" (0x400 or most negative position).

The resolution of the secure position is limited to 9 bit at start-up. The OTP register is copied in RAM as illustrated below. The RAM bits SecPos1 and SecPos0 are set to 0.



### Shaft

A shaft bit, which can be programmed in <u>OTP</u> or with command <u>SetMotorParam</u>, defines whether a positive motion is a clockwise (CW) or counter-clockwise rotation (CCW) (an outer or an inner motion for linear actuators):

- Shaft = 0 ⇒ MOTXP is used as positive pin of the X coil, while MOTXN is the negative one.
- Shaft =  $1 \Rightarrow$  opposite situation

**Exception:** in RunVelocity mode, the shaft bit has no function. In this mode the rotational direction is always CW or CCW, which is only determined by the motor wiring.

### STRUCTURAL DESCRIPTION

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See also the Block Diagram in Figure 1.

### **Stepper Motordriver**

The Motordriver receives the control signals from the control logic. The main features are:

• Two H-bridges, designed to drive a stepper motor with two separated coils. Each coil (X and Y) is driven by one H-bridge, and the driver controls the currents flowing through the coils. The rotational position of the rotor, in unloaded condition, is defined by the ratio of current flowing in X and Y. The torque of the stepper motor when unloaded is controlled by the magnitude of the currents in X and Y.

• The control block for the H-bridges, including the PWM control, the synchronous rectification and the internal current sensing circuitry.

- The charge pump to allow driving of the H-bridges' high side transistors.
- Two pre-scale 4-bit DAC's to set the maximum magnitude of the current through X and Y.
- Two DAC's to set the correct current ratio through X and Y.

Battery voltage monitoring is also performed by this block, which provides the required information to the control logic part. The same applies for detection and reporting of an electrical problem that could occur on the coils or the charge pump.

### **Control Logic (Position Controller and Main Control)**

The control logic block stores the information provided by the LIN interface (in a RAM or an OTP memory) and digitally controls the positioning of the stepper motor in terms of speed and acceleration, by feeding the right signals to the motordriver state machine.

It will take into account the successive positioning commands to properly initiate or stop the stepper motor in order to reach the set point in a minimum time.

It also receives feedback from the motordriver part in order to manage possible problems and decide on internal actions and reporting to the LIN interface.

#### **Motion Detection**

Motion detection is based on the back-emf generated internally in the running motor. When the motor is blocked,

e.g. when it hits the end position, the velocity, and as a result also the generated back–emf, is disturbed. The AMIS–30623 senses the back–emf, calculates a moving average and compares the value with two independent threshold levels. If the back–emf disturbance is bigger than the set threshold, the running motor is stopped.

### LIN Interface

The LIN interface implements the physical layer and the MAC and LLC layers according to the OSI reference model. It provides and gets information to and from the control logic block, in order to drive the stepper motor, to configure the way this motor must be driven, or to get information such as actual position or diagnosis (temperature, battery voltage, electrical status...) and pass it to the LIN master node.

### Miscellaneous

The AMIS-30623 also contains the following:

- An internal oscillator, needed for the LIN protocol handler as well as the control logic and the PWM control of the motordriver.
- An internal trimmed voltage source for precise referencing.
- A protection block featuring a thermal shutdown and a power-on-reset circuit.
- A 5 V regulator (from the battery supply) to supply the internal logic circuitry.

### **FUNCTIONS DESCRIPTION**

This chapter describes the following functional blocks in more detail:

- Position controller
- Main control and register, OTP memory + ROM
- Motordriver

The Motion detection and LIN controller are discussed in separate chapters.

#### Position Controller

#### **Positioning and Motion Control**

A positioning command will produce a motion as illustrated in Figure 7. A motion starts with an acceleration phase from minimum velocity (Vmin) to maximum velocity (Vmax) and ends with a symmetrical deceleration. This is defined by the control logic according to the position required by the application and the parameters programmed by the application during the configuration phase. The current in the coils is also programmable.

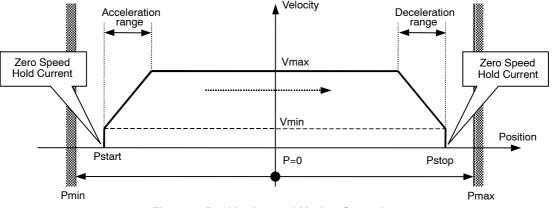


Figure 7. Positioning and Motion Control

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### Table 13. POSITION RELATED PARAMETERS

Parameter	Reference
Pmax – Pmin	See Positioning
Zero Speed Hold Current	See Ihold
Maximum Current	See Irun
Acceleration and Deceleration	See Acceleration and Deceleration
Vmin	See <u>Minimum Velocity</u>
Vmax	See Maximum Velocity

Different positioning examples are shown in the table below.

### Table 14. POSITIONING EXAMPLES

Short motion.	Velocity
	time
New positioning command in same dir- ection, shorter or longer, while a motion is running at maximum velocity.	Velocity
New positioning command in same dir- ection while in deceleration phase (Note 20)	▲ Velocity
<b>Note:</b> there is no wait time between the deceleration phase and the new acceleration phase.	time
New positioning command in reverse direction while motion is running at max- imum velocity.	Velocity
New positioning command in reverse direction while in deceleration phase.	Velocity
New velocity programming while motion is running.	Velocity time

20. Reaching the end position is always guaranteed, however velocity rounding errors might occur after consecutive accelerations during a deceleration phase. The velocity rounding error will be removed at Vmin (e.g. at end of acceleration or when AccShape=1).

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### **Dual Positioning**

A <u>SetDualPosition</u> command allows the user to perform a positioning using two different velocities. The first motion is done with the specified Vmin and Vmax velocities in the <u>SetDualPosition</u> command, with the acceleration (deceleration) parameter already in RAM, to a position Pos1[15:0] also specified in <u>SetDualPosition</u>.

Then a second relative motion to a physical position Pos1[15:0] + Pos2[15:0] is done at the specified Vmin velocity in the <u>SetDualPosition</u> command (no acceleration). Once the second motion is achieved, the ActPos register is reset to zero, whereas TagPos register is not changed.

When the Secure position is enabled, after the dual positioning, the secure positioning is executed. The figure below gives a detailed overview of the dual positioning function. After the dual positioning is executed an internal flag is set to indicate the AMIS-30623 is referenced.

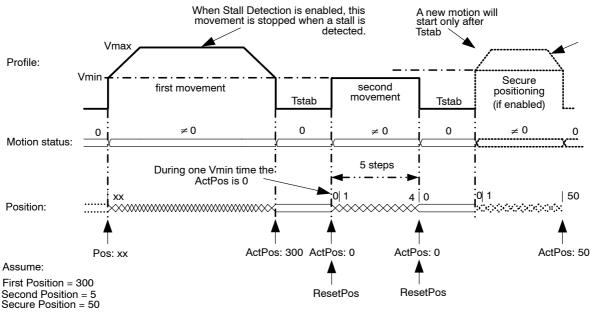


Figure 8. Dual Positioning

**Remark:** This operation cannot be interrupted or influenced by any further command unless the occurrence of the conditions driving to a motor shutdown or by a <u>HardStop</u> command. Sending a <u>SetDualPosition</u> command while a motion is already ongoing is not recommended.

21. The priority encoder is describing the management of states and commands.

- 22. A DualPosition sequence starts by setting TagPos buffer register to SecPos value, provided secure position is enabled otherwise TagPos is reset to zero. If a SetPosition(Short) command is issued during a DualPosition sequence, it will be kept in the position buffer memory and executed afterwards. This applies also for the commands Sleep, SetPosParam and GotoSecurePosition.
- 23. Commands such as GetActualPos or GetStatus will be executed while a Dual Positioning is running. This applies also for a dynamic ID assignment LIN frame.
- 24. The Pos1, Pos2, Vmax and Vmin values programmed in a <u>SetDualPosition</u> command apply only for this sequence. All other motion parameters are used from the RAM registers (programmed for instance by a former SetMotorParam command). After the DualPosition motion is completed, the former Vmin and Vmax become active again.

25. Commands ResetPosition, SetDualPosition, and SoftStop will be ignored while a DualPosition sequence is ongoing, and will not be executed afterwards.

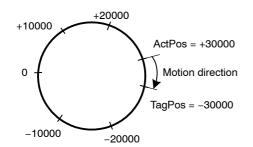
26. Recommendation: a SetMotorParam command should not be sent during a <u>SetDualPosition</u> sequence: all the motion parameters defined in the command, except Vmin and Vmax, become active immediately.

#### **Position Periodicity**

Depending on the stepping mode the position can range from -4096 to +4095 in half-step to -32768 to +32767 in 1/16th micro-stepping mode. One can project all these positions lying on a circle. When executing the command <u>SetPosition</u>, the position controller will set the movement direction in such a way that the traveled distance is minimal. The figure below illustrates that the moving direction going from ActPos = +30000 to TagPos = -30000 is clockwise.

If a counter clockwise motion is required in this example, several consecutive <u>SetPosition</u> commands can be used. One could also use for larger movements the command <u>RunVelocity</u>.

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### Hardwired Address HW2

In the drawing below, a simplified schematic diagram is shown of the HW2 comparator circuit.

The HW2 pin is sensed via 2 switches. The DriveHS and DriveLS control lines are alternatively closing the top and bottom switch connecting HW2 pin with a current to resistor converter. Closing  $S_{TOP}$  (DriveHS = 1) will sense a current to GND. In that case the top I $\rightarrow$  R converter output is low, via the closed passing switch  $S_{PASS}$  T this signal is fed to the "R" comparator which output HW2\_Cmp is high. Closing bottom switch  $S_{BOT}$  (DriveLS = 1) will sense a current to  $V_{BAT}$ . The corresponding I  $\rightarrow$  R converter output is low and via  $S_{PASS}$  B fed to the comparator. The output HW2\_Cmp will be high.

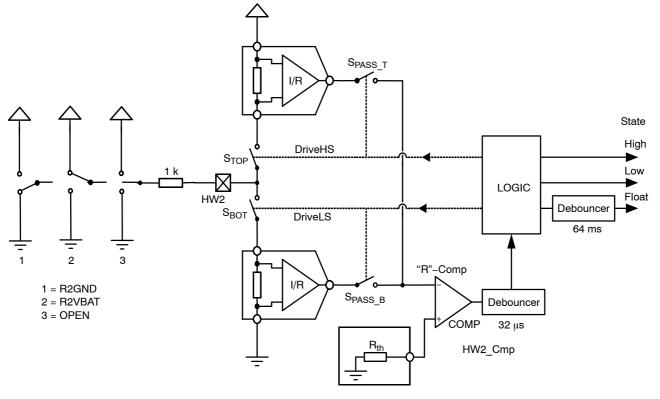


Figure 10. Simplified Schematic Diagram of the HW2 Comparator

3 cases can be distinguished (see also Figure 10 above):

- HW2 is connected to ground: R2GND or drawing 1
- HW2 is connected to VBAT: R2VBAT or drawing 2
- HW2 is floating: OPEN or drawing 3

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Previous State	DriveLS	DriveHS	HW2_Cmp	New State	Condition	Drawing
Float	1	0	0	Float	R2GND or OPEN	1 or 3
Float	1	0	1	High	R2VBAT	2
Float	0	1	0	Float	R2VBAT or OPEN	2 or 3
Float	0	1	1	Low	R2GND	1
Low	1	0	0	Low	R2GND or OPEN	1 or 3
Low	1	0	1	High	R2VBAT	2
Low	0	1	0	Float	R2VBAT or OPEN	2 or 3
Low	0	1	1	Low	R2GND	1
High	1	0	0	Float	R2GND or OPEN	1 or 3
High	1	0	1	High	R2VBAT	2
High	0	1	0	High	R2VBAT or OPEN	2 or 3
High	0	1	1	Low	R2GND	1

### Table 15. STATE DIAGRAM OF THE HW2 COMPARATOR

The logic is controlling the correct sequence in closing the switches and in interpreting the 32  $\mu$ s debounced HW2\_Cmp output accordingly. The output of this small state-machine is corresponding to:

• High or address = 1

- Low or address = 0
- Floating

As illustrated in the table above (Table 15), the state is depending on the previous state, the condition of the 2 switch controls (DriveLS and DriveHS) and the output of HW2\_Cmp. Figure 11 shows an example of a practical case where a connection to VBAT is interrupted.

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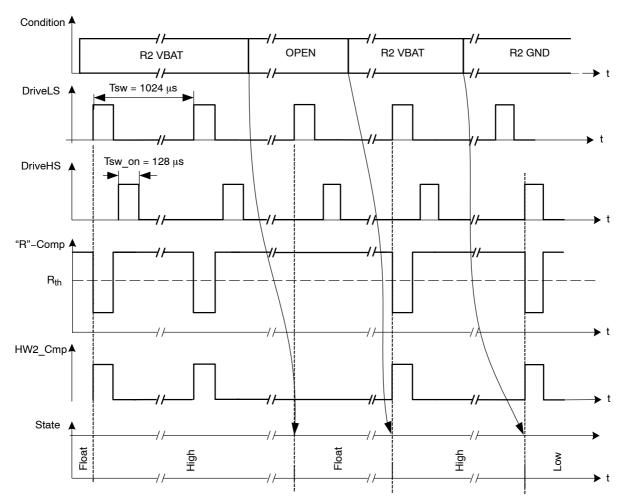


Figure 11. Timing Diagram Showing the Change in States for HW2 Comparator

### R2VBAT

A resistor is connected between VBAT and HW2. Every 1024  $\mu$ s S<sub>BOT</sub> is closed and a current is sensed. The output of the I  $\Rightarrow$  R converter is low and the HW2\_Cmp output is high. Assuming the previous state was floating, the internal logic will interpret this as a change of state and the new state will be high (see also Table 15). The next time S<sub>BOT</sub> is closed the same conditions are observed. The previous state was high so based on Table 15 the new state remains unchanged. This high state will be interpreted as HW2 address = 1.

### OPEN

In case the HW2 connection is lost (broken wire, bad contact in connector) the next time  $S_{BOT}$  is closed, this will be sensed. There will be no current, the output of the corresponding I  $\Rightarrow$  R converter is high and the HW2\_Cmp will be low. The previous state was high. Based in Table 15 one can see that the state changes to float. This will trigger

a motion to secure position after a debounce time of 64 ms, which prevents false triggering in case of micro– interruptions of the power supply.

### R2GND

If a resistor is connected between HW2 and the GND, a current is sensed every 1024  $\mu$ s when S<sub>TOP</sub> is closed. The output of the top I  $\Rightarrow$  R converter is low and as a result the HW2\_Cmp output switches to high. Again based on the stated diagram in Table 15 one can see that the state will change to Low. This low state will be interpreted as HW2 address = 0.

#### **External Switch SWI**

As illustrated in Figure 12 the SWI comparator is almost identical to HW2. The major difference is in the limited number of states. Only open or closed is recognised leading to respectively ESW = 0 and ESW = 1.

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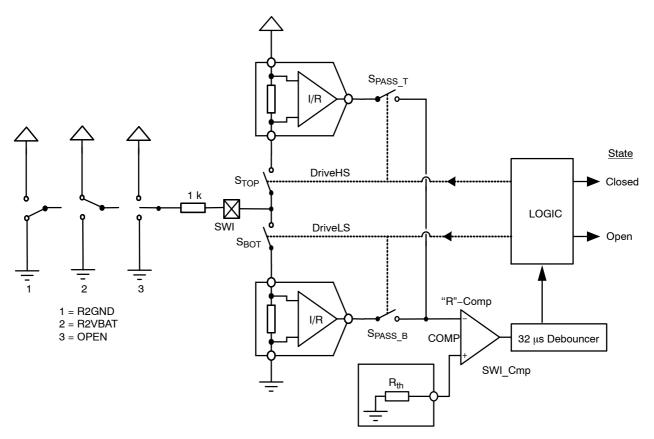


Figure 12. Simplified Schematic Diagram of the SWI Comparator

As illustrated in the drawing above, a change in state is always synchronised with DriveHS or DriveLS. The same synchronisation is valid for updating the internal position register. This means that after every current pulse (or closing of  $S_{TOP}$  or  $S_{BOT}$ ) the state of the position switch together with the corresponding position is memorised.

The <u>GetActualPos</u> command reads back the <ActPos> register and the status of ESW. In this way the master node may get synchronous information about the state of the switch together with the position of the motor. See Table 16 below.

	Reading Frame										
			Structure								
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
0	Identifier	*	*	1	0	ID3	ID2	ID1	ID0		
1	Data 1	ESW	ESW AD[6:0]								
2	Data 2				ActPos	s[15:8]					
3	Data 3				ActPo	os[7:0]					
4	Data 4	VddReset	StepLoss ElDef UV2 TSD TW Tinfo[1:0]						p[1:0]		
5	Checksum		Checksum over data								

### Table 16. GetActualPos LIN COMMAND

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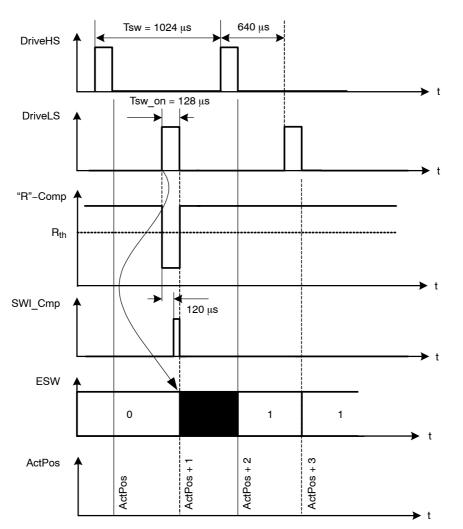


Figure 13. Simplified Timing Diagram Showing the Change in States for SWI Comparator

### Main Control and Register, OTP memory + ROM

#### **Power-up Phase**

Power-up phase of the AMIS-30623 will not exceed 10 ms. After this phase, the AMIS-30623 is in standby mode, ready to receive LIN messages and execute the associated commands. After power-up, the registers and flags are in the reset state, while some of them are being loaded with the OTP memory content (see Table 19: RAM Registers).

#### Reset

After power-up, or after a reset occurrence (e.g. a micro-cut on pin  $V_{BB}$  has made  $V_{DD}$  to go below VddReset level), the H-bridges will be in high-impedance mode, and the registers and flags will be in a predetermined position. This is documented in Table 19: RAM Registers and Table 20: Flags Table.

### Soft-stop

A soft-stop is an immediate interruption of a motion, but with a deceleration phase. At the end of this action, the register <TagPos> is loaded with the value contained in register <ActPos>, see Table 19: Ram Registers). The circuit is then ready to execute a new positioning command, provided thermal and electrical conditions allow for it.

#### Sleep Mode

When entering sleep mode, the stepper-motor can be driven to its secure position. After which, the circuit is completely powered down, apart from the LIN receiver, which remains active to detect a dominant state on the bus. In case sleep mode is entered while a motion is ongoing, a transition will occur towards secure position as described in <u>Positioning and Motion Control</u> provided <SecPos> is enabled. Otherwise, <SoftStop> is performed.

Sleep mode can be entered in the following cases:

- The circuit receives a LIN frame with identifier **0x3C** and first data byte containing **0x00**, as required by LIN specification rev 1.3 and <SleepEn> bit = 1. See also <u>Sleep</u> in the LIN Application Command section.
- In case the >SleepEn> bit = 1 and the LIN bus remains inactive (or is lost) during more than 25000 time slots (1.30 s at 19.2 kbit/s), a time-out signal switches the circuit to sleep mode.

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The circuit will return to normal mode if a valid LIN frame is received (this valid frame can be addressed to another slave).

### **Thermal Shutdown Mode**

When thermal shutdown occurs, the circuit performs a <SoftStop> command and goes to motor shutdown mode (see Figure 14: State Diagram Temperature Management).

### **Temperature Management**

The AMIS-30623 monitors temperature by means of two thresholds and one shutdown level, as illustrated in the state diagram and illustration of Figure 14: State Diagram Temperature Management below. The only condition to reset flags <TW> and <TSD> (respectively thermal warning and thermal shutdown) is to be at a temperature lower than Ttw and to get the occurrence of a <u>GetStatus</u> or a GetFullStatus LIN frame.

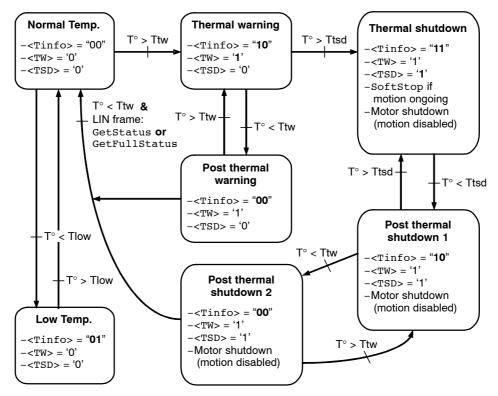


Figure 14. State Diagram Temperature Management

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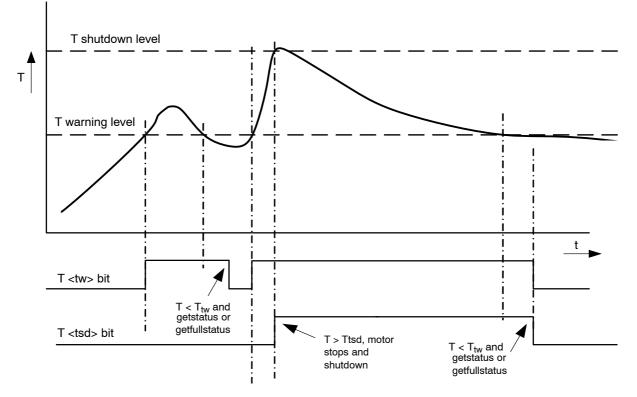


Figure 15. Illustration of Thermal Management Situation

## Autarkic Functionality in Under-Voltage Condition

### **Battery Voltage Management**

The AMIS-30623 monitors the battery voltage by means of one threshold and one shutdown level. The only condition to reset flags <UV2> and <StepLoss> is to recover by a battery voltage higher than UV1 and to receive a <u>GetStatus</u> or a <u>GetFullStatus</u> command.

#### **Autarkic Function**

The device enters states <HardUnder> (see Figure 16), followed by <ShutUnder> when  $V_{BB}$  is below the UV2 level or <CPFail> = 1. The motion is stopped immediately and Target Position (TagPos) is kept and not overwritten by Actual Position (ActPos). The motor is in HiZ state and the flags <UV2> and <Steploss> are set to inform the master that the voltage has dropped below UV2 or the charge pump voltage has dropped below the level of the charge pump comparator and loss of steps is possible.

• If in this state V<sub>BB</sub> becomes > UV1 within 15 seconds, then AMIS-30623 returns to <Stopped> state. From there, it resumes the interrupted motion and accepts updates of the target position by means of the commands <u>SetPosition</u>, <u>SetPositionShort</u>, <u>SetPosParam</u> and <u>GotoSecurePosition</u>, even if the <UV2> flag, the <CPFail> flag and <Steploss> flags are NOT cleared.

• If however the  $V_{BB}$  voltage remains below UV2 level or the charge pump voltage level is below the charge pump comparator for more than 15 seconds, then the device will enter <Shutdown> state and the target position is overwritten by Actual Position. This state can be exited only if  $V_{BB}$  is > UV1, the charge pump voltage is above the charge pump comparator voltage and an incoming command <u>GetStatus</u> or <u>GetFullStatus</u> is received.

### **Important Notes:**

- 1. In the case of Autarkic positioning, care needs to be taken because accumulated steploss can cause a significant deviation between physical and stored actual position.
- The <u>SetDualPosition</u> command will only be executed after clearing the <UV2>, CPFail and <Steploss> flags.
- 3. RAM reset occurs when Vdd < VddReset (digital Power-On-Reset level).
- 4. The Autarkic function remains active as long as V<sub>DD</sub> > VddReset.

## 

### **OTP Register**

### **OTP Memory Structure**

The table below shows how the parameters to be stored in the OTP memory are located.

Address	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x00	OSC3	OSC2	OSC1	OSC0	IREF3	IREF2	IREF1	IREF0
0x01	EnableLIN	TSD2	TSD1	TSD0	BG3	BG2	BG1	BG0
0x02	AbsThr3	AbsThr2	AbsThr1	AbsThr0	PA3	PA2	PA1	PA0
0x03	Irun3	Irun2	Irun1	Irun0	lhold3	Ihold2	lhold1	Ihold0
0x04	Vmax3	Vmax2	Vmax1	Vmax0	Vmin3	Vmin2	Vmin1	Vmin0
0x05	SecPos10	SecPos9	SecPos8	Shaft	Acc3	Acc2	Acc1	Acc0
0x06	SecPos7	SecPos6	SecPos5	SecPos4	SecPos3	SecPos2	Failsafe	SleepEn
0x07	DelThr3	DelThr2	DelThr1	DelThr0	StepMode1	StepMode0	LOCKBT	LOCKBG

### Table 17. OTP MEMORY STRUCTURE

Parameters stored at address 0x00 and 0x01 and bit <LOCKBT> are already programmed in the OTP memory at circuit delivery. They correspond to the calibration of the circuit and are just documented here as an indication.

Each OTP bit is at '0' when not zapped. Zapping a bit will set it to '1'. Thus only bits having to be at '1' must be zapped. Zapping of a bit already at '1' is disabled. Each OTP byte will be programmed separately (see command <u>SetOTPparam</u>). Once OTP programming is completed, bit <LOCKBG> can be zapped to disable future zapping, otherwise any OTP bit at '0' could still be zapped by using a <u>SetOTPparam</u> command.

### Table 18. OTP OVERWRITE PROTECTION

Lock Bit	Protected Bytes
LOCKBT (factory zapped before delivery)	0x00 to 0x01
LOCKBG	0x00 to 0x07

The command used to load the application parameters via the LIN bus in the RAM prior to an OTP Memory programming is <u>SetMotorParam</u>. This allows for a functional verification before using a <u>SetOTPparam</u> command to program and zap separately one OTP memory byte. A <u>GetOTPparam</u> command issued after each <u>SetOTPparam</u> command allows verifying the correct byte zapping.

**Note:** Zapped bits will become active only after a power cycle. After programming the LIN bits the power cycle has to be performed first to guarantee further communication with the device.

### Application Parameters Stored in OTP Memory

Except for the physical address <PA[3:0]> these parameters, although programmed in a non-volatile memory can still be overridden in RAM by a LIN writing operation.

- **PA[3:0]** In combination with HW[2:0] it forms the physical address AD[6:0] of the stepper-motor. Up to 128 stepper-motors can theoretically be connected to the same LIN bus.
- AbsThr[3:0] Absolute threshold used for the motion detection

Index		Abs	Thr		AbsThr level (V) (*)
0	0	0	0	0	Disable
1	0	0	0	1	0.5
2	0	0	1	0	1.0
3	0	0	1	1	1.5
4	0	1	0	0	2.0
5	0	1	0	1	2.5
6	0	1	1	0	3.0
7	0	1	1	1	3.5
8	1	0	0	0	4.0
9	1	0	0	1	4.5
А	1	0	1	0	5.0
В	1	0	1	1	5.5
С	1	1	0	0	6.0
D	1	1	0	1	6.5
E	1	1	1	0	7.0
F	1	1	1	1	7.5

(\*) Not tested in production. Values are approximations.

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Index		Deľ	Thr		DelThr Level (V) (*)
0	0	0	0	0	Disable
1	0	0	0	1	0.25
2	0	0	1	0	0.50
3	0	0	1	1	0.75
4	0	1	0	0	1.00
5	0	1	0	1	1.25
6	0	1	1	0	1.50
7	0	1	1	1	1.75
8	1	0	0	0	2.00
9	1	0	0	1	2.25
А	1	0	1	0	2.50
В	1	0	1	1	2.75
С	1	1	0	0	3.00
D	1	1	0	1	3.25
E	1	1	1	0	3.50
F	1	1	1	1	3.75

**DelThr[3:0]** Relative threshold used for the motion detection

(\*) Not tested in production. Values are approximations.

**Irun[3:0]** Current amplitude value to be fed to each coil of the stepper-motor. The table below provides the 16 possible values for <IRUN>.

Index		Iru	ın		Run Current (mA)
0	0	0	0	0	59
1	0	0	0	1	71
2	0	0	1	0	84
3	0	0	1	1	100
4	0	1	0	0	119
5	0	1	0	1	141
6	0	1	1	0	168
7	0	1	1	1	200
8	1	0	0	0	238
9	1	0	0	1	283
A	1	0	1	0	336
В	1	0	1	1	400
С	1	1	0	0	476
D	1	1	0	1	566
E	1	1	1	0	673
F	1	1	1	1	800

**Ihold[3:0]** Hold current for each coil of the stepper-motor. The table below provides the 16 possible values for <IHOLD>.

Index		lho	old		Hold Current (mA)
0	0	0	0	0	59
1	0	0	0	1	71
2	0	0	1	0	84
3	0	0	1	1	100
4	0	1	0	0	119
5	0	1	0	1	141
6	0	1	1	0	168
7	0	1	1	1	200
8	1	0	0	0	238
9	1	0	0	1	283
А	1	0	1	0	336
В	1	0	1	1	400
С	1	1	0	0	476
D	1	1	0	1	566
E	1	1	1	0	673
F	1	1	1	1	0

**Note:** When the motor is stopped, the current is reduced from <IRUN> to <IHOLD>. In the case of 0 mA hold current (1111 in the hold current table), the following sequence is applied:

- 1. The current is first reduced to 59 mA (corresponding to 0000 value in the table).
- 2. The PWM regulator is switched off; the bottom transistors of the bridges are grounded.

**StepMode** Setting of step modes.

StepMode		Step Mode
0	0	1/2 stepping
0	1	1/4 stepping
1	0	1/8 stepping
1	1	1/16 stepping

**Shaft** This bit distinguishes between a clock-wise or counter-clock-wise rotation. The shaft bit is not working in RunVelocity mode.

SecPos[10:2] Secure Position of the
stepper-motor. This is the position to which the
motor is driven in case of a LIN communication
loss or when the LIN error-counter overflows.
If <SecPos[10:2]> = "100 0000 00xx",
secure positioning is disabled; the
stepper-motor will be kept in the position
occupied at the moment these events occur.

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**Note:** The Secure Position is coded on 11 bits only, providing actually the most significant bits of the position, the non coded least significant bits being set to '0'. The Secure Position in OTP has only 9 bits. The two least significant bits are loaded as '0' to RAM when copied from OTP.

Vmax[3:0]	Maximum velocity
-----------	------------------

Index	Vmax				Vmax(full step/s)	Group
0	0	0	0	0	99	А
1	0	0	0	1	136	
2	0	0	1	0	167	
3	0	0	1	1	197	В
4	0	1	0	0	213	В
5	0	1	0	1	228	
6	0	1	1	0	243	
7	0	1	1	1	273	
8	1	0	0	0	303	
9	1	0	0	1	334	С
А	1	0	1	0	364	U
В	1 (		1	1	395	
С	1	1	0	0	456	
D	1	1	0	1	546	
E	1	1	1	0	729	D
F	1	1	1	1	973	

Vmin[3:0] Minimum velocity.

Index		Vn	nin		Vmax Factor
0	0	0	0	0	1
1	0	0	0	1	1/32
2	0	0	1	0	2/32
3	0	0	1	1	3/32
4	0	1	0	0	4/32
5	0	1	0	1	5/32
6	0	1	1	0	6/32
7	0	1	1	1	7/32
8	1	0	0	0	8/32
9	1	0	0	1	9/32
А	1	0	1	0	10/32
В	1	0	1	1	11/32
С	1	1	0	0	12/32
D	1	1	0	1	13/32
E	1	1	1	0	14/32
F	1	1	1	1	15/32

Acc[3:0]	Acceleration and deceleration between
Vmax	and Vmin.

Index		A	cc		Acceleration (Full-step/s <sup>2</sup> )		
0	0	0	0	0	49 (*)		
1	0	0	0	1	218 (*)		
2	0	0	1	0	1004 .		
3	0	0	1	1	3609 .		
4	0	1	0	0	6228 .		
5	0	1	0	1	8848 .		
6	0	1	1	0	11409 .		
7	0	1	1	1	13970 .		
8	1	0	0	0	16531 .		
9	1	0	0	1	19092 (*)		
А	1	0	1	0	21886 (*)		
В	1	0	1	1	24447 (*)		
С	1	1	0	0	27008 (*)		
D	1	1	0	1	29570 (*)		
E	1	1	1	0	34925 (*)		
F	1	1	1	1	40047 (*)		

(\*) restriction on speed

**SleepEn** IF <SleepEn> = 1 -> AMIS-30623 always goes to low-power sleep mode incase of LIN timeout.

> IF <SleepEn> = 0, there is no more automatic transition to low-current sleep mode (i.e. stay in stop mode with applied hold current, unless there are failures). Exception to this rule are the states <Standby> and <Shutdown>, in which the device can enter sleep regardless of the state of SleepEn.

**Note:** The <SleepEn> function acts for the LIN command "SLEEP" too. When <SleepEn> = 1 and the Sleep command is received the 30623 will go into Sleep. In case the <SleepEn> = 0 the 30623 will go into stop mode.

### FailSafe

Description: see section LIN Lost Behavior.

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### Table 19. RAM REGISTERS

Register	Mnemonic	Length (bit)	Related Commands	Comment	Reset State
Actual position	ActPos	16	<u>GetActualPos</u> <u>GetFullStatus</u> <u>GotoSecurePos</u> <u>ResetPosition</u>	16-bit signed	
Last programmed Position	Pos/TagPos	16/11	GetFullStatus GotoSecurePos ResetPosition SetPositionShort SetPosParam	16-bit signed or 11-bit signed for half stepping (see <u>Positioning</u> )	
Acceleration shape	AccShape	1	<u>GetFullStatus</u> <u>SetMotorParam</u>	'0' $\Rightarrow$ normal acceleration from Vmin to Vmax '1' $\Rightarrow$ motion at Vmin without acceleration	ʻ0'
Coil peak current	Irun	4	<u>GetFullStatus</u> <u>SetMotorParam</u>	Operating current See look-up table <u>Irun</u>	
Coil hold current	lhold	4	<u>GetFullStatus</u> <u>SetMotorParam</u>	Standstill current See look-up table <u>Ihold</u>	
Minimum Velocity	Vmin	4	<u>GetFullStatus</u> <u>SetMotorParam</u> <u>SetPosParam</u>	See Section <u>Minimum Velocity</u> See look-up table <u>Vmin</u>	
Maximum Velocity	Vmax	4	<u>GetFullStatus</u> <u>SetMotorParam</u> <u>SetPosParam</u>	See Section <u>Maximum Velocity</u> See look-up table <u>Vmax</u>	
Shaft	Shaft	1	<u>GetFullStatus</u> <u>SetMotorParam</u>	Direction of movement	
Acceleration/ deceleration	Acc	4	<u>GetFullStatus</u> <u>SetMotorParam</u> <u>SetPosParam</u>	See Section <u>Acceleration</u> See look-up table <u>Acc</u>	From OTP memory
Secure Position	SecPos	11	<u>GetFullStatus</u> <u>SetMotorParam</u>	Target position when LIN connection fails; 11 MSB's of 16-bit position (LSB's fixed to '0')	
Stepping mode	StepMode	2	<u>GetFullStatus</u> <u>SetStallParam</u>	See Section <u>Stepping Modes</u> See look-up table <u>StepMode</u>	
Stall detection absolute threshold	AbsThr	4	<u>GetFullStatus</u> <u>SetStallParam</u> <u>SetPosParam</u>		
Stall detection delta threshold	DelThr	4	<u>GetFullStatus</u> <u>SetStallParam</u>		
Sleep Enable	SleepEn	1	<u>SetOTPParam</u>	Enables entering sleep mode after LIN lost. See also <u>LIN lost behavior</u>	
Fail Safe	FailSafe	1	<u>SetOTPParam</u>	Triggers autonomous motion after LIN lost at POR. See also <u>LIN lost behavior</u>	
Stall detection delay	FS2StallEn	3	<u>GetFullStatus</u> <u>SetStallParam</u>	Delays the stall detection after acceleration	'000'
Stall detection sampling	MinSamples	3	<u>GetFullStatus</u> <u>SetStallParam</u>	Duration of the zero current step in number of PWM cycles.	'000'
PWM Jitter	PWMJEn	1	<u>GetFullStatus</u> <u>SetStallParam</u>	'1' means jitter is added	ʻ0'
100% duty cycle Stall Enable	DC100StEn	1	<u>GetFullStatus</u> <u>SetStallParam</u>	'1' means stall detection is enabled in case PWM regulator runs at $\delta$ = 100%	ʻ0'
PWM frequency	PWMFreq	1	<u>GetFullStatus</u> <u>SetMotorParam</u>	'0' means ~ 22 KHz, '1' means ~ 44 KHz	'O'

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### Table 20. FLAGS TABLE

Flag	Flag Mnemonic (bit) Related Com		Related Commands	Comment	Reset State
Charge pump failure	CPFail	1	<u>GetFullStatus</u>	'0' = charge pump OK '1' = charge pump failure Resets only after <u>GetFullStatus</u>	ʻ0'
Electrical defect	ElDef	1	<u>GetActualPos</u> <u>GetStatus</u> <u>GetFullStatus</u>	<pre>&lt;0VC1&gt; or &lt;0VC2&gt; or 'open-load on coil X' or 'open-load on coil XY or <cpfail> Resets only after <u>Get(Full)Status</u></cpfail></pre>	ʻ0'
External switch status	ESW	1	GetActualPos'0' = openGetStatus'1' = closeGetFullStatus		ʻ0'
Electrical flag	HS	1	Internal use	<cpfail> or <uv2> or <eldef> or <vddreset></vddreset></eldef></uv2></cpfail>	'0'
Motion status	Motion	3	GetFullStatus       "x00" = Stop         "001" = inner (CCW) motion acceleration         "010" = inner (CCW) motion deceleration         "011" = inner (CCW) motion max. speed         "101" = outer (CW) motion acceleration         "110" = outer (CW) motion deceleration         "111" = outer (CW) motion max. speed		"000"
Over current in coil X	OVC1	1	<u>GetFullStatus</u>	'1' = over current; reset only after <u>GetFullStatus</u>	'0'
Over current in coil Y	OVC2	1	<u>GetFullStatus</u>	'1' = over current; reset only after <u>GetFullStatus</u>	'0'
Secure position enabled	SecEn	1	Internal use	'0' if <secpos> = "100 0000 0000" '1' otherwise</secpos>	n.a.
Circuit going to Sleep mode	Sleep	1	Internal use	Internal use '1' = Sleep mode reset by LIN command	
Step loss	StepLoss	1	GetActualPos'1' = step loss due to under voltage, over current, open circuit or stall; Resets only after GetFullStatus or GetActualPos		'1'
Delta High Stall	DelStallHi	1	<u>GetFullStatus</u>	<u>GetFullStatus</u> '1' = Vbemf > Ubemf + DeltaThr	
Delta Low Stall	DelStallLo	1	<u>GetFullStatus</u>	'1' = Vbemf < Ubemf - DeltaThr	'0'
Absolute Stall	AbsStall	1	<u>GetFullStatus</u>	'1' = Vbemf < AbsThr	'0'
Stall	Stall	1	<u>GetFullStatus</u> <u>GetStatus</u>		ʻ0'
Motor stop	Stop	1	Internal use		<b>'</b> 0'
Temperature info	Tinfo	2	<u>GetActualPos</u> <u>GetStatus</u> <u>GetFullStatus</u>	"00" = normal temperature range "01" = low temperature warning "10" = high temperature warning "11" = motor shutdown	"00"
Thermal shutdown	TSD	1	<u>GetActualPos</u> <u>GetStatus</u> <u>GetFullStatus</u>	'1' = shutdown (T <sub>j</sub> > T <sub>tsd</sub> ) Resets only after <u>Get(Full)Status</u> and if <tinfo> = "00"</tinfo>	'0'
Thermal warning	TW	1	GetActualPos       '1' = over temperature (T <sub>j</sub> > T <sub>tw</sub> )         GetStatus       Resets only after Get(Full)Status         GetFullStatus       and if <tinfo> = "00"</tinfo>		'0'
Battery stop voltage	UV2	1	$\begin{tabular}{lllllllllllllllllllllllllllllllllll$		ʻ0'
Digital supply reset	VddReset	1	<u>GetActualPos</u> <u>GetStatus</u> <u>GetFullStatus</u>	Set at '1' after power-up of the circuit. If this was due to a supply micro-cut, it warns that the RAM contents may have been lost; can be reset to '0' with a <u>GetStatus</u> or a <u>Get(Full)Status</u> command	'1'

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### **Priority Encoder**

The table below describes the simplified state management performed by the main control block.

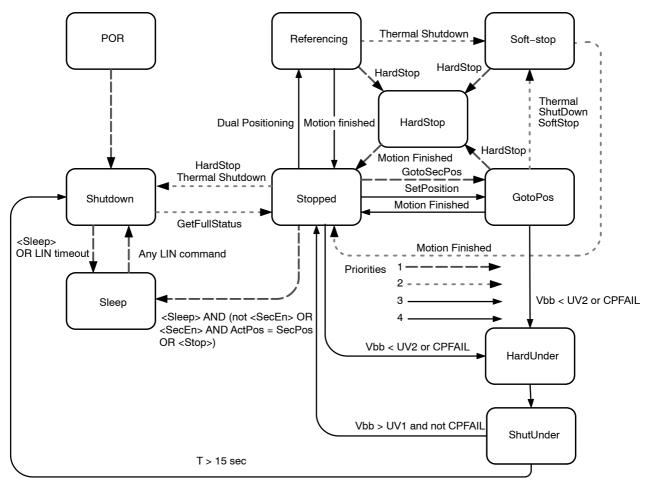
### Table 21. PRIORITY ENCODER

State →	Standby	Stopped	GotoPos	DualPosition	SoftStop	HardStop	ShutDown	Sleep	HardUnder	ShutUnder
Command ↓		Motor Stopped, Ihold in Coils	Motor Motion Ongoing	No Influence on RAM and TagPos	Motor Decelerating	Motor Forced to Stop	Motor Stopped, H-bridges in Hi–Z	No Power (Note 27)		
GetActualPos	LIN in-frame response	LIN in-frame response	LIN in-frame response	LIN in-frame response	LIN in-frame response	LIN in-frame response	LIN in-frame response		LIN in-frame response	LIN in-frame response
GetOTPparam	LIN in-frame response	LIN in-frame response	LIN in-frame response	LIN in-frame response	LIN in-frame response	LIN in-frame response	LIN in-frame response		LIN in-frame response	LIN in-frame response
GetFullStatus or GetStatus [ attempt to clear <tsd> and <hs> flags]</hs></tsd>	LIN in-frame response; if ( <tsd> or <hs>) = '0' then → <b>Stopped</b></hs></tsd>	LIN in-frame response	LIN in-frame response	LIN in-frame response	LIN in-frame response	LIN in-frame response	LIN in-frame response; if ( <tsd> or <hs>) = '0' then → <b>Stopped</b></hs></tsd>		LIN in-frame response	
SetMotorParam [Master takes care about proper update]	RAM update	RAM update	RAM update	RAM update	RAM update	RAM update	RAM update		RAM update	RAM update
ResetPosition		<tagpos> and <actpos> reset</actpos></tagpos>					<tagpos> and <actpos> reset</actpos></tagpos>			<tagpos> and <actpos> reset</actpos></tagpos>
SetPosition		<tagpos> updated; → <b>GotoPos</b></tagpos>	<tagpos> updated</tagpos>	<tagpos> updated</tagpos>						
SetPositionShort		<tagpos> updated; → <b>GotoPos</b></tagpos>	<tagpos> updated</tagpos>	<tagpos> updated</tagpos>						
GotoSecPosition		If <secen> = '1' then <tagpos> = <secpos>; → GotoPos</secpos></tagpos></secen>	If <secen> = '1' then <tagpos> = <secpos></secpos></tagpos></secen>	If <secen> = '1' then <tagpos> = <secpos></secpos></tagpos></secen>						
DualPosition		$\rightarrow$ DualPosition								
SoftStop			$\rightarrow$ SoftStop							
Sleep or LIN timeout [ ⇒ <sleep> = '1', reset by any LIN command received later]</sleep>	→ Sleep	(Note 35)	If <secen> = '1' then <tagpos> = <secpos> else → SoftStop</secpos></tagpos></secen>	If <secen> = '1' then <tagpos> = <secpos>; will be evaluated after DualPosition</secpos></tagpos></secen>	No action; <sleep> flag will be evaluated when motor stops</sleep>	No action; <sleep> flag will be evaluated when motor stops</sleep>	No action; <sleep> flag will be evaluated when motor stops</sleep>		No action; <sleep> flag will be evaluated when motor stops</sleep>	
HardStop			$\rightarrow$ HardStop	$\rightarrow$ HardStop	$\rightarrow$ HardStop					
V <sub>BB</sub> < UV2 and t > 15 seconds		$\rightarrow$ HardUnder	$\rightarrow$ HardUnder	$\rightarrow$ HardStop	$\rightarrow$ HardUnder					
V <sub>BB</sub> < UV2 and t < 15 seconds										$\rightarrow$ Stopped
<eldef> = '1' ⇒ <hs> = '1'</hs></eldef>		→ Shutdown	→ HardStop; <steploss> = '1'</steploss>	→ HardStop; <steploss> = '1'</steploss>	→ HardStop; <steploss> = '1'</steploss>					→ Shutdown
Thermal shutdown [ <tsd> = '1']</tsd>		→ Shutdown	→ SoftStop	→ SoftStop						→ Shutdown
Motion finished		n.a.	$\rightarrow$ Stopped	$\rightarrow$ Stopped	→ Stopped; <tagpos> = <actpos></actpos></tagpos>	→ Stopped; <tagpos> = <actpos></actpos></tagpos>	n.a.	n.a.		
I			W	ith the Foll	owing Cold	or Code:				
Comma	nd Ignored			Another Stat			esponsible fo	or proper u	update (see	Note 33)

NOTE: See table notes on the following page.

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- 27. Leaving <Sleep> state is equivalent to power-on-reset.
- 28. After power-on-reset, the <Standby> state is entered.
- 29. A DualPosition sequence runs with a separate set of RAM registers. The parameters that are not specified in a DualPosition command are loaded with the values stored in RAM at the moment the DualPosition sequence starts. <AccShape> is forced to '1' during second motion. <AccShape> at '0' will be taken into account after the DualPosition sequence. A <u>GetFullStatus</u> command will return the default parameters for <Vmax> and <Vmin> stored in RAM.
- 30. The <Sleep> flag is set to '1' when a LIN timeout or a <u>Sleep</u> command occurs. It is reset by the next LIN command (<Sleep> is cancelled if not activated yet).
- 31. Shutdown state can be left only when <TSD> and <HS> flags are reset.
- 32. Flags can be reset only after the master could read them via a <u>GetStatus</u> or <u>GetFullStatus</u> command, and provided the physical conditions allow for it (normal temperature, correct battery voltage and no electrical or charge pump defect).
- 33. A <u>SetMotorParam</u> command sent while a motion is ongoing (state <GotoPos>) should not attempt to modify <Acc> and <Vmin> values. This can be done during a DualPosition sequence since this motion uses its own parameters, the new parameters will be taken into account at the next <u>SetPosition</u> or <u>SetPositionShort</u> command.
- 34. Some transitions like  $\langle \text{GotoPos} \rangle \rightarrow \langle \text{Sleep} \rangle$  are actually done via several states:  $\langle \text{GotoPos} \rangle \rightarrow \langle \text{SoftStop} \rangle \rightarrow \langle \text{Stopped} \rangle \rightarrow \langle \text{Sleep} \rangle$  (see diagram below).
- 35. Two transitions are possible from state <Stopped> when <Sleep> = '1':
- 1) Transition to state <Sleep> if (<SecEn> = '0') or ((<SecEn> = '1') and (<ActPos> = <SecPos>)) or <Stop> = '1'
- 2) Otherwise transition to state <GotoPos>, with <TagPos> = <SecPos>
- 36. <SecEn> = '1' when register <SecPos> is loaded with a value different from the most negative value (i.e. different from 0x400 = "100 0000").
- 37.<Stop> flag allows distinguishing whether state <Stopped> was entered after HardStop/SoftStop or not. <Stop> is set to '1' when leaving state <HardStop> or <SoftStop> and is reset during first clock edge occurring in state <Stopped>.
- 38. Command for dynamic assignment of Ids is decoded in all states except <Sleep> and has no effect on the current state.
- 39. While in state <Stopped>, if <ActPos> → <TagPos> there is a transition to state <GotoPos>. This transition has the lowest priority, meaning that <Sleep>, <Stop>, <TSD>, etceteras are first evaluated for possible transitions.
- 40.lf <StepLoss> is active, then <u>SetPosition</u>, <u>SetPositionShort</u> and <u>GotoSecurePosition</u> commands **are not** ignored. <StepLoss> can only be cleared by a <u>GetStatus</u> or GetFullStatus command.





**Remark:** IF <SleepEn> = 0, then the arrow from stopped state to sleep state does not exist.

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### Motordriver

### **Current Waveforms in the Coils**

Figure 17 below illustrates the current fed to the motor coils by the motordriver in half-step mode.

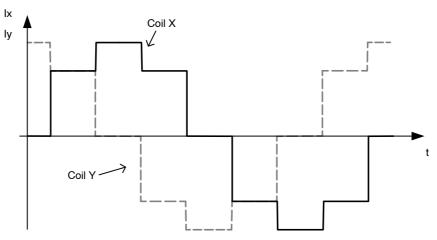


Figure 17. Current Waveforms in Motor Coils X and Y in Halfstep Mode

Whereas Figure 18 below shows the current fed to the coils in 1/16<sup>th</sup> micro stepping (1 electrical period).

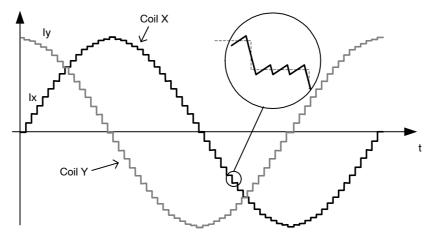


Figure 18. Current Waveforms in Motor Coils X and Y in 1/16<sup>th</sup> Micro-Step Mode

### **PWM Regulation**

In order to force a given current (determined by <Irun> or <Ihold> and the current position of the rotor) through the motor coil while ensuring high energy transfer efficiency, a regulation based on PWM principle is used. The regulation loop performs a comparison of the sensed output current to an internal reference, and features a digital regulation generating the PWM signal that drives the output switches. The zoom over one micro-step in the Figure 18 above shows how the PWM circuit performs this regulation. To reduce the current ripple, a higher PWM frequency is selectable. The RAM register PWMfreq is used for this.

### **Table 22. PWM FREQUENCY SELECTION**

PWMfreq	Applied PWM Frequency
0	22,8 kHz
1	45,6 kHz

### **PWM Jitter**

To lower the power spectrum for the fundamental and higher harmonics of the PWM frequency, jitter can be added to the PWM clock. The RAM register <PWMJEn> is used for this.

### Table 23. PWM JITTER SELECTION

PWMJEn	Status	
0	Single PWM frequency	
1	Added jitter to PWM frequency	

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### **Motor Starting Phase**

At motion start, the currents in the coils are directly switched from **<Ihold>** to **<Irun>** with a new sine/cosine ratio corresponding to the first half (or micro-) step of the motion.

#### **Motor Stopping Phase**

At the end of the deceleration phase, the currents are maintained in the coils at their actual DC level (hence keeping the sine/cosine ratio between coils) during the stabilization time  $t_{stab}$  (see <u>AC Table</u>). The currents are then set to the hold values, respectively **Ihold** x sin(TagPos) and **Ihold** x cos(TagPos), as illustrated below. A new positioning order can then be executed.

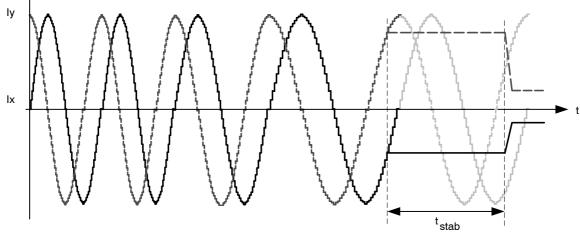


Figure 19. Motor Stopping Phase

#### **Charge Pump Monitoring**

If the charge pump voltage is not sufficient for driving the high side transistors (due to failure), an internal <u>HardStop</u> command is issued. This is acknowledged to the master by raising flag <CPFail> (available with command <u>GetFullStatus</u>).

In case this failure occurs while a motion is ongoing, the flag <StepLoss> is also raised.

### **Electrical Defect on Coils, Detection and Confirmation**

The principle relies on the detection of a voltage drop on at least one transistor of the H–bridge. Then the decision is taken to open the transistors of the defective bridge.

This allows the detection the following short circuits:

- External coil short circuit
- Short between one terminal of the coil and Vbat or Gnd

One cannot detect an internal short in the motor.

Open circuits are detected by 100% PWM duty cycle value during one electrical period with duration, determined by Vmin.

### **Table 24. ELECTRICAL DEFECT DETECTION**

Pins	Fault Mode		
Yi or Xi	Short-circuit to GND		
Yi or Xi	Short-circuit to Vbat		
Yi or Xi	Open		
Y1 and Y2	Short circuited		
X1 and X2	Short circuited		
Xi and Yi	Short circuited		

#### Motor Shutdown Mode

A motor shutdown occurs when:

- The chip temperature rises above the thermal shutdown threshold Ttsd (see <u>Thermal Shutdown Mode</u>).
- The battery voltage goes below UV2 for longer than 15 seconds (see <u>Battery Voltage Management</u>).
- The charge pump voltage goes below the charge pump comparator level for more than 15 seconds.
- Flag <ElDef> = '1', meaning an electrical problem is detected on one or both coils, e.g. a short circuit.

A motor shutdown leads to the following:

- H-bridges in high impedance mode.
- The <TagPos> register is loaded with the <ActPos>, except in autarkic states.
- The LIN interface remains active, being able to receive orders or send status.

The conditions to get out of a motor shutdown mode are:

- Reception of a <u>GetStatus</u> or <u>GetFullStatus</u> command <u>AND</u>
- The four above causes are no longer detected

This leads to H-bridges going in Ihold mode. Hence, the circuit is ready to execute any positioning command.

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This can be illustrated in the following sequence given as an application example. The master can check whether there is a problem or not and decide which application strategy to adopt.

Table 25. Example of Possible Sequ	uence used to Detect and Determine Cause of Motor Shutdown

$\begin{array}{c} Tj \geq Tsd \; or \\ V_{BB} \leq UV2 \; (>15s) \; or \\ <\texttt{ElDef>} = `1' \; or \\ <\texttt{CPFail>} = `1' \; (>15s) \\ \downarrow \end{array}$	SetPosition frame ↓	GetFullStatus or GetStatus frame ↓	GetFullStatus or GetStatus frame ↓
– The circuit is driven in motor shutdown mode	<ul> <li>The position set-point is updated by the LIN Master</li> <li>Motor shutdown mode ⇒ no motion</li> <li>The application is still unaware</li> </ul>	<ul> <li>The application is aware of a problem</li> </ul>	<ul> <li>Possible confirmation of the problem</li> </ul>
<ul> <li>The application is <u>not</u> aware of this</li> </ul>		<ul> <li>Reset <tw> or <tsd> or <uv2> or <steploss> or <eldef> or <cpfail> by the application</cpfail></eldef></steploss></uv2></tsd></tw></li> <li>Possible new detection of over temperature or low voltage or electrical problem ⇒ Circuit sets <tw> or <tsd> or <uv2> or <steploss> or <eldef> or <cpfail> again at '1'</cpfail></eldef></steploss></uv2></tsd></tw></li> </ul>	

**Important:** While in shutdown mode, since there is no hold current in the coils, the mechanical load can cause a step loss, which indeed cannot be flagged by the AMIS–30623.

If the LIN communication is lost while in shutdown mode, the circuit enters the sleep mode immediately.

**Note:** The <u>Priority Encoder</u> is describing the management of states and commands.

**Warning:** The application should limit the number of consecutive <u>GetStatus</u> or <u>GetFullStatus</u> commands to try to get the AMIS–30623 out of shutdown mode when this proves to be unsuccessful, e.g. there is a permanent defect. The reliability of the circuit could be altered since <u>Get(Full)Status</u> attempts to disable the protection of the H–bridges.

### **Motion Detection**

Motion detection is based on the back emf generated internally in the running motor. When the motor is blocked, e.g. when it hits the end-stop, the velocity and as a result also the generated back emf, is disturbed. The AMIS-30623 senses the back emf, calculates a moving average and compares the value with two independent threshold levels: Absolute threshold (<u>AbsThr[3:0]</u>) and Delta threshold (<DelThr[3:0]>). Instructions for correct use of these two levels in combination with three additional parameters (<MinSamples>, <FS2StallEn> and <DC100StEn>) are available in a dedicated Application Note "Robust Motion Control with AMIS-3062x Stepper Motor Drivers".

If the motor is accelerated by a pulling or propelling force and the resulting back emf increases above the Delta threshold (+ $\Delta$ THR), then <DelStallHi> is set. When the motor is slowing down and the resulting back emf decreases below the Delta threshold (- $\Delta$ THR), then <DelStallLo> is set. When the motor is blocked and the velocity is zero after the acceleration phase, the back emf is low or zero. When this value is below the Absolute threshold, <AbsStall> is set. The <Stall> flag is the OR function of <DelStallLo> OR <DelStallHi> OR <AbsStall>.

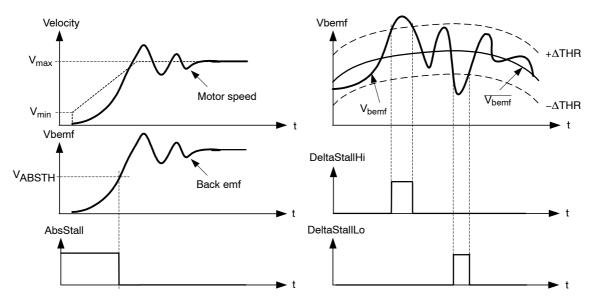


Figure 20. Triggering of the Stall Flags in Function of Measured Backemf and the Set Threshold Levels

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### Table 26. TRUTH TABLE

Condition	<delstalllo></delstalllo>	<delstallhi></delstallhi>	<absstall></absstall>	<stall></stall>
Vbemf < Average – DelThr	1	0	0	1
Vbemf > Average + DelThr	0	1	0	1
Vbemf < AbsThr	0	0	1	1

By design, the motion will only be detected when the motor is running at the maximum velocity, not during acceleration or deceleration.

If the motor is positioning when Stall is detected, an (internal) hardstop of the motor is generated and the <StepLoss> and <Stall> flags are set. These flags can only be reset by sending a <u>GetFullStatus</u> command.

If Stall appears during DualPosition then the first phase is cancelled (via internal hardstop) and after timeout Tstab (see AC table) the second phase at Vmin starts.

When the <Stall> flag is set the position controller will generate an internal HardStop. As a consequence also the <Steploss> flag will be set. The position in the internal counter will be copied to the <ActPos> register. All flags can be read out with the <u>GetStatus</u> or <u>GetFullStatus</u> command.

## Important Remark (limited to motion detection flags / parameters):

Using <u>GetFullStatus</u> will read **AND** clear the following flags: <Steploss>, <Stall>, <AbsStall>, <DelStallLo> and <DelStallHi>. New positioning is possible and the <ActPos> register will be further updated.

Using <u>GetStatus</u> will read **AND** clear **ONLY** the <Steploss> flag. The <Stall>, <AbsStall>, <DelStallLo> and <DelStallHi> flags are **NOT** cleared. New positioning is possible and the <ActPos> register will be further updated.

Motion detection is disabled when the RAM registers <AbsThr[3:0]> and <DelThr[3:0]> are zero. Both levels can be programmed using the LIN command SetStallParam in the registers <AbsThr[3:0]> and <DelThr[3:0]>. Also the OTP register <AbsThr[3:0]> and <DelThr[3:0]> can be set using the LIN command <u>SetOTPParam</u>. These values are copied in the RAM registers during power on reset.

Table 27.
ABSOLUTE AND DELTA THRESHOLD SETTINGS

AbsThr Index	AbsThr Level (V) (*)	DelThr Index	DelThr Level (V) (*)
0	Disable	0	Disable
1	0.5	1	0.25
2	1.0	2	0.50
3	1.5	3	0.75
4	2.0	4	1.00
5	2.5	5	1.25
6	3.0	6	1.50
7	3.5	7	1.75
8	4.0	8	2.00
9	4.5	9	2.25
А	5.0	Α	2.50
В	5.5	В	2.75
С	6.0	С	3.00
D	6.5	D	3.25
E	7.0	E	3.50
F	7.5	F	3.75

(\*) Not tested in production. Values are approximations.

### MinSamples

<MinSamples[2:0]> is a programmable delay timer. After the zero crossing is detected, the delay counter is started. After the delay time-out ( $t_{delay}$ ) the back-emf sample is taken. For more information please refer to the Application Note "Robust Motion Control with AMIS-3062x Stepper Motor Drivers".

Table 28. BACK EMF SAMPLE DELAY TIME

Index	MinSamples[2:0]	t <sub>DELAY</sub> (μs)	
0	000	87	
1	001	130	
2	010	174	
3	011	217	
4	100	261	
5	101	304	
6	110	348	
7	111	391	

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### FS2StallEn

If <AbsThr> or <DelThr> <> 0 (i.e. motion detection is enabled), then stall detection will be activated AFTER the acceleration ramp + an additional number of full-steps, according to the following table:

#### Table 29. ACTIVATION DELAY OF MOTION DETECTION

Index	FS2StallEn[2:0]	Delay (Full Steps)	
0	000	0	
1	001	1	
2	010	2	
3	011	3	
4	100	4	
5	101	5	
6	110	6	
7	111	7	

### DC100StEn

When a motor with large bemf is operated at high speed and low supply voltage, then the PWM duty cycle can be as high as 100%. This indicates that the supply is too low to generate the required torque and might also result in erroneously triggering the stall detection. The bit <DC100StEn> enables stall detection when duty cycle is 100%. For more information please refer to the Application Note "Robust Motion Control with AMIS-3062x Stepper Motor Drivers".

### Motion Qualification Mode (\*)

This mode is useful to debug motion parameters and to verify the stability of stepper motor systems. The motion qualification mode is entered by means of the LIN command <u>TestBemf</u>. The SWI pin will be converted into an analogue output on which the Back EMF integrator output can be measured. Once activated, it can only be stopped after a POR. During the Back emf observation, reading of the SWI state is internally forbidden.

(\*) **Note:** Not applicable for product versions AMIS30623C6238(R)G and AMIS30623C623B(R)G.

More information is available in the Application Note "Robust Motion Control with AMIS–3062x Stepper Motor Drivers".

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### LIN CONTROLLER

### **General Description**

The LIN (local interconnect network) is a serial communications protocol that efficiently supports the control of mechatronics nodes in distributed automotive applications. The physical interface implemented in the AMIS–30623 is compliant to the LIN rev. 2.0 & 2.1 specifications. It features a slave node, thus allowing for:

- single-master / multiple-slave communication
- self synchronization without quartz or ceramics resonator in the slave nodes
- guaranteed latency times for signal transmission
- single-signal-wire communication
- transmission speed of 19.2 kbit/s

- selectable length of Message Frame: 2, 4, and 8 bytes
- configuration flexibility
- data checksum (classic checksum, cf. LIN1.3) security and error detection
- detection of defective nodes in the network

It includes the analog physical layer and the digital protocol handler.

The analog circuitry implements a low side driver with a pull–up resistor as a transmitter, and a resistive divider with a comparator as a receiver. The specification of the line driver/receiver follows the ISO 9141 standard with some enhancements regarding the EMI behavior.

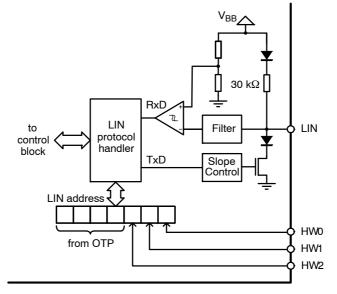


Figure 21. LIN Interface

### Slave Operational Range for Proper Self Synchronization

The LIN interface will synchronize properly in the following conditions:

- Vbat  $\ge 8 \text{ V}$
- Ground shift between master node and slave node <  $\pm 1 \text{ V}$

It is highly recommended to use the same type of reverse battery voltage protection diode for the Master and the Slave nodes.

### **Functional Description**

### **Analog Part**

The transmitter is a low–side driver with a pull–up resistor and slope control. The receiver mainly consists of a comparator with a threshold equal to  $V_{BB}/2$ . Figure 5 shows

### Table 30. LIN ERROR REGISTER

the characteristics of the transmitted and received signal. See <u>AC Parameters</u> for timing values.

### **Protocol Handler**

This block implements:

- Bit synchronization
- Bit timing
- The MAC layer
- The LLC layer
- The supervisor

### Error Status Register

The LIN interface implements a register containing an error status of the LIN communication. This register is as follows:

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Not	Not	Not	Not	Time	Data	Header	Bit
used	used	used	used	out error	error Flag	error Flag	error Flag

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With:

Data error flag: (= Checksum error + StopBit error + Length error)

Header error flag: (= Parity error + SynchField error)

Time out flag: The message frame is not fully completed within the maximum length

Bit error flag: Difference in bit sent and bit monitored on the LIN bus

A  $\underline{\texttt{GetFullStatus}}$  frame will reset the error status register.

#### **Physical Address of the Circuit**

The circuit must be provided with a physical address in order to discriminate this circuit from other ones on the LIN bus. This address is coded on 7 bits, yielding the theoretical possibility of 128 different circuits on the same bus. It is a combination of 4 OTP memory bits and of the 3 hardwired address bits (pins HW[2:0]). However the maximum number of nodes in a LIN network is also limited by the physical properties of the bus line. It is recommended to limit the number of nodes in a LIN network to not exceed 16. Otherwise the reduced network impedance may prohibit a fault free communication under worst case conditions. Every additional node lowers the network impedance by approximately 3%.

AD6	AD5	AD4	AD3	AD2	AD1	AD0	Physical address
Ŷ	Ŷ	$\uparrow$	PA3	PA2	PA1	PA0	OTP memory
HWO	HW1	HW2					Hardwired bits

NOTE: Pins HW0 and HW1 are 5 V digital inputs, whereas pin HW2 is compliant with a 12 V level, e.g. it can be connected to Vbat or Gnd via a terminal of the PCB. For SetPositionShort it is recommended to set HW0, HW1 and HW2 to '1'.

### LIN Frames

The LIN frames can be divided in writing and reading frames. A frame is composed of an 8-bit Identifier followed by 2, 4 or 8 data-bytes and a checksum byte.

**Note:** The checksum is conform LIN1.3, classic checksum calculation over only data bytes. (Checksum is an inverted 8–bit sum with carry over all data bytes.)

Writing frames will be used to:

- Program the OTP Memory;
- Configure the component with the stepper-motor parameters (current, speed, stepping-mode, etc.);
- Provide set-point position for the stepper-motor;
- Control the motion state machine.

Whereas reading frames will be used to:

- Get the actual position of the stepper-motor;
- Get status information such as error flags;
- Verify the right programming and configuration of the component.

#### Writing Frames

The LIN master sends commands and/or information to the slave nodes by means of a writing frame. According to the LIN specification, identifiers are to be used to determine a specific action. If a physical addressing is needed, then some bits of the data field can be dedicated to this, as illustrated in the example below.

	Identifier Byte					Data Byte 1				Data Byte 2											
ID0	D0 ID1 ID2 ID3 ID4 ID5 ID6 ID7				ID7																
						phys. address comm			comma	nand parameters (e.g. position)											

<ID6> and <ID7> are used for parity check over <ID0> to <ID5>, conform LIN1.3 specification. <ID6> = <ID0>  $\otimes$  <ID1>  $\otimes$  <ID2>  $\otimes$  <ID4> (even parity) and <ID7> = NOT(<ID1>  $\otimes$  <ID3>  $\otimes$  <ID4>  $\otimes$  <ID5>) (odd parity).

Another possibility is to determine the specific action within the data field in order to use less identifiers. One can for example use the reserved identifier 0x3C and take advantage of the 8 byte data field to provide a physical address, a command and the needed parameters for the action, as illustrated in the example below.

ID		Data Byte 1	Data Byte 2	Data Byte 3	Data Byte 4	Data Byte 5	Data Byte 6	Data Byte 7	Data Byte 8
0x3C	00	1							
		AppCmd	command	physical address			parameters		

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NOTE: Bit 7 of Data byte 1 must be at '1' since the LIN specification requires that contents from 0x00 to 0x7F must be reserved for broadcast messages (0x00 being for the "Sleep" message). See also LIN command <u>Sleep</u>

The writing frames used with the AMIS–30623 are the following:

**Type #1:** General purpose 2 or 4 data bytes writing frame with a dynamically assigned identifier. This type is dedicated to short writing actions when the bus load can be an issue. They are used to provide direct command to one (<Broad> = '1') or all the slave nodes (<Broad> = '0'). If <Broad> = '1', the physical address of the slave node is provided by the 7 remaining bits of DATA2. DATA1 will contain the command code (see <u>Dynamic</u> <u>assignment of Identifiers</u>), while, if present, DATA3 to DATA4 will contain the command parameters, as shown below.

	ID				Data1	Data2	Data3				
ID0	ID1	ID2	ID3	ID4	ID5	ID6	ID7	command	Physical address	Broad	Parameters

NOTE: <ID4> and <ID5> indicate the number of data bytes.

NOTE.		<1032 Indicate the number of data bytes.
ID5	ID4	Ndata (number of data fields)
0	0	2
0	1	2
1	0	4
1	1	8

- **Type #2:** two, four or eight data bytes writing frame with an identifier dynamically assigned to an application command, regardless of the physical address of the circuit.
- **Type #3:** two data bytes writing frame with an identifier dynamically assigned to a particular slave node together with an application command. This type of frame requires that there are as many dynamically assigned identifiers as there are AMIS-30623 circuits using this command connected to the LIN bus.
- **Type #4:** eight data bytes writing frame with 0x3C identifier.

#### **Reading Frames**

A reading frame uses an in-frame response mechanism. That is: the master initiates the frame (synchronization field + identifier field), and <u>one</u> slave sends back the data field together with the check field. Hence, two types of identifiers can be used for a reading frame:

- Direct ID, which points at a particular slave node, indicating at the same time which kind of information is awaited from this slave node, thus triggering a specific command. This ID provides the fastest access to a read command but is forbidden for any other action.
- Indirect ID, which only specifies a reading command, the physical address of the slave node that must answer having been passed in a previous writing frame, called a preparing frame. Indirect ID gives more flexibility than a direct one, but provides a slower access to a read command.

- 1. A reading frame with indirect ID must always be consecutive to a preparing frame. It will otherwise not be taken into account.
- 2. A reading frame will always return the physical address of the answering slave node in order to ensure robustness in the communication.

The reading frames, used with the AMIS–30623, are the following:

**Type #5:** two, four or eight Data bytes reading frame with a direct identifier dynamically assigned to a particular slave node together with an application command. A preparing frame is not needed.

**Type #6:** eight Data bytes reading frame with 0x3D identifier. This is intrinsically an indirect type, needing therefore a preparation frame. It has the advantage to use a reserved identifier. (Note: because of the parity calculation done by the master, the identifier becomes 0x7D as physical data over the bus).

#### Preparing Frames

A preparing frame is a frame from the master that warns a particular slave node that it will have to answer in the next frame (being a reading frame). A preparing frame is needed when a reading frame does not use a dynamically assigned direct ID. Preparing and reading frames must be consecutive. A preparing frame will contain the physical address of the LIN slave node that must answer in the reading frame and will also contain a command indicating which kind of information is awaited from the slave.

The preparing frames used with the AMIS–30623 can be of type #7 or type #8 described below.

**Type #7:** two data bytes writing frame with dynamically assigned identifier. The identifier of the preparing frame has to be assigned to ROM pointer 1000, see Table 34.

				Structure						
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier	*	*	0	ID4	ID3	ID2	ID1	ID0	
1	Data 1	1				CMD[6:0]				
2	Data 2	1	AD[6:0]							
3	Checksum		Checksum over data							

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#### Table 31. PREPARING FRAME #7

#### Where:

(\*) According to parity computation

Type #8: eight data bytes preparing frame with 0x3C identifier.

			Structure							
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier	0	0	1	1	1	1	0	0	
1	Data 1		AppCMD =							
2	Data 2	1	1 CMD[6:0]							
3	Data 3	1 AD[6:0]								
4	Data 4				Data4[	7:0] FF				
5	Data 5				Data5[	7:0] FF				
6	Data 6		Data6[7:0] FF							
7	Data 7	Data7[7:0] FF								
8	Data 8	Data8[7:0] FF								
9	Checksum				Checksum	over data				

#### Table 32. PREPARING FRAME #8

Where:

AppCMD: If = '0x80' this indicates that Data 2 contains an application command

CMD[6:0]: Application Command "byte"

AD[6:0]: Slave node physical address

Data[7:0]: Data transmitted

#### **Dynamic Assignment of Identifiers**

The identifier field in the LIN datagram denotes the content of the message. Six identifier bits and two parity bits are used to represent the content. The identifiers 0x3C and 0x3F are reserved for command frames and extended frames. Slave nodes need to be very flexible to adapt itself to a given LIN network in order to avoid conflicts with slave nodes from different manufacturers. Dynamic assignment of the identifiers will fulfill this requirement by writing identifiers into the circuits RAM. ROM pointers are linking commands and dynamic identifiers together. A writing

frame with identifier 0x3C issued by the LIN master will write dynamic identifiers into the RAM. One writing frame is able to assign 4 identifiers; therefore 3 frames are needed to assign all identifiers. Each ROM pointer <ROMp\_x [3:0]> place the corresponding dynamic identifier <Dyn\_ID\_x [5:0]> at the correct place in the RAM (see Table below: LIN – Dynamic Identifiers Writing Frame).

When setting <Broad> to zero broadcasting is active and each slave on the LIN bus will store the same dynamic identifiers, otherwise only the slave with the corresponding slave address is programmed.

			Structure							
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier									
1	AppCMD				0x	(80				
2	CMD	1			0x11					
3	Address	Broad	AD6	AD5	AD4	AD3	AD2	AD1	AD0	
4	Data		DynID	_1[3:0]		_1[3:0]				
5	Data	DynID	_2[1:0]	ROMp_2[3:0] DynID_1[5:4]						
6	Data		ROMp	_3[3:0]						
7	Data	ROMp	_4[1:0]							
8	Data			DynID_4[5:0] ROMp_4[3:2]					_4[3:2]	
9	Checksum		Checksum over data							

#### Table 33. DYNAMIC IDENTIFIERS WRITING FRAME

Where:

CMD[6:0]: 0x11, corresponding to dynamic assignment of four LIN identifiers

Broad: If <Broad> = '0' all the circuits connected to the LIN bus will share the same dynamically assigned identifiers.

Dyn\_ID\_x [5:0]: Dynamically assigned LIN identifier to the application command which ROM pointer is <ROMp\_x [3:0]>

One frame allows only assigning of four identifiers. Therefore, additional frames could be needed in order to assign more identifiers (maximum three for the AMIS-30623).

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Dynamic ID	ROM pointer	Application Command
User Defined	0010	GetActualPos
User Defined	0011	GetStatus
User Defined	0100	► SetPosition
User Defined	0101	SetPositionShort (1 m)
User Defined	0110	SetPositionShort (2 m)
User Defined	0111	SetPositionShort (4 m)
User Defined	0000	GeneralPurpose 2 bytes
User Defined	0001	GeneralPurpose 4 bytes
User Defined	1000	<ul> <li>Preparation Frame</li> </ul>

---> Command assignment via Dynamic ID during operation

Figure 22. Principle of Dynamic Command Assignment

#### **Commands Table**

#### Table 34. LIN COMMANDS WITH CORRESPONDING ROM POINTER

Command Mnemonic	Command B	yte (CMD)	Dynamic ID (example)	ROM Pointer
<u>GetActualPos</u>	000000	0x00	100xxx	0010
<u>GetFullStatus</u>	000001	0x01	n.a.	
GetOTPparam	000010	0x02	n.a.	
GetStatus	000011	0x03	000xxx	0011
GotoSecurePosition	000100	0x04	n.a.	
HardStop	000101	0x05	n.a.	
ResetPosition	000110	0x06	n.a.	
RunVelocity	010111	0x17	n.a.	
SetDualPosition	001000	0x08	n.a.	
<u>SetMotorParam</u>	001001	0x09	n.a.	
<u>SetOTPparam</u>	010000	0x10	n.a.	
SetStallParam	010110	0x16	n.a.	
SetPosition (16-bit)	001011	0x0B	010xxx	0100
SetPositionShort (1 motor)	001100	0x0C	001001	0101
SetPositionShort (2 motors)	001101	0x0D	101001	0110
SetPositionShort (4 motors)	001110	0x0E	111001	0111
<u>SetPosParam</u>	101111	0x2F	110xxx	1001
Sleep	n.a.		n.a.	
SoftStop	001111	0x0F	n.a.	
TestBemf	011111	0x1F	n.a.	
Dynamic ID assignment	010001	0x11	n.a.	
<u>General purpose 2 Data bytes</u>			011000	0000
<u>General purpose 4 Data bytes</u>			101000	0001
Preparing frame			011010	1000

NOTE: "xxx" allows addressing physically a slave node. Therefore, these dynamic identifiers cannot be used for more than eight stepper motors. Only ten ROM pointers are needed for the AMIS–30623.

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#### LIN Lost Behavior

#### Introduction

When the LIN communication is broken for a duration of 25000 consecutive frames (= 1,30s @ 19200 kbit/s) AMIS-30623 sets an internal flag called "LIN lost". The functional behavior depends on the state of OTP bits <SleepEn> and <FailSafe>, and if this loss in LIN

#### Table 35. SLEEP ENABLE SELECTION

communication occurred at (or before) power on reset or in normal powered operation.

#### Sleep Enable

The OTP bit <SleepEn> enables or disables the entering in low-power sleep mode in case of LIN time-out. Default the entering of the sleep-mode is disabled.

<sleepen></sleepen>	Behavior
0	Entering low-power sleep mode is disabled except from <standby> and <shutdown></shutdown></standby>
1	Entering low-power sleep mode enabled

#### **Fail Safe Motion**

The OTP bit <FailSafe> enables or disables an automatic motion to a predefined secure position. See also Autonomous Motion.

Table 36. FAIL	SAFE ENABLE	SELECTION
----------------	-------------	-----------

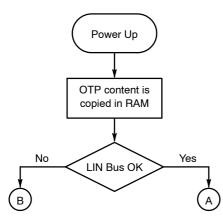
<failsafe></failsafe>	Behavior
0	NO reference motion in case of LIN – lost
1	ENABLES reference motion to a secure position in case of LIN-lost (if the device has not been yet referenced with SetDualPosition)

AMIS-30623 is able to perform an Autonomous Motion to a preferred position. This positioning starts after the detection of lost LIN communication and depends on:

- the OTP bit <FailSafe> = 1.

- RAM register < SecPos [10:0]>  $\neq$  0x400

The functional behavior depends if LIN communication is lost during normal operation (see figure below case A) or at (or before) startup (case B):



#### Figure 23. Flow Chart Power–Up of AMIS–30623 (Case A: LIN lost during operation and Case B: LIN lost at startup)

#### LIN Lost During Normal Operation

If the LIN communication is lost during normal operation, it is assumed that AMIS-30623 is referenced (by Dual postioning or Resetposition). In other words the <ActPos> register contains the "real" actual position. At LIN – lost an absolute positioning to the stored secure position SecPos is done. This is further called Secure Positioning. If OTP bit <FailSafe> = 1, the reaction is the following: If the device has already been referenced, it is assumed that <ActPos> register contains the "real" actual position. At LIN – lost an absolute positioning to the stored secure position SecPos is done (identical to the case, when OTP bit <FailSafe> = 0).

If the device was not referenced yet, the <ActPos> register does not contain a valid position. At LIN – lost a referencing is started using DualPositioning. A first negative motion of half the positioner range is initiated until the stall position is reached. The motion parameters stored in OTP will be used for this. After this mechanical end-position is reached, <ActPos> will be reset to zero. A second motion of 10 Fullsteps is executed to assure that the motion is really at the end position. After the second motion, a third motion is executed to the Secure Position also stored in OTP; if <SecPos> = 0x400, this second motion is not executed.

Following sequence will be followed. See Figure 24.

- 1. <SecPos [ 10:0 ]> from RAM register will be used. This can be different from OTP register if earlier LIN master communication has updated this. See also <u>Secure Position</u> and command <u>SetMotorParam</u>.
  - I. If <SecPos[10:0]> = 0x400: No Secure Positioning will be performed
  - II. If <SecPos[10:0]> ≠ 0x400: Perform a Secure Positioning. This is an absolute positioning (slave knows its ActPos. <SecPos[10:0]> will be copied in <TaqPos>)

Depending on <Sleep> AMIS-30623 will enter the <Stop> state or the <Sleep> state. See Table 35.

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#### **Important Remarks:**

- 1. The Secure Position has a resolution of 11 bit.
- 2. Same behavior in case of HW2 float (= lost LIN address), except for entering Sleep mode. If HW2 is floating, but there is LIN communication, Sleep mode is not entered. See also <u>Hardwired Address HW2</u>.

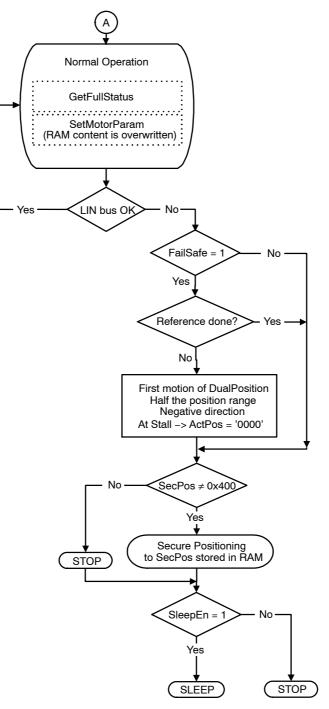


Figure 24. Case A: LIN Lost During Normal Operation

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#### LIN Lost Before or At Power On

If the LIN communication is lost before or at power on, the <ActPos> register does not reflect the "real" actual position. So at LIN – lost a referencing is started using DualPositioning. A first negative motion for half the

positioner range is initiated until the stall position is reached. The motion parameters stored in OTP will be used for this. After this mechanical end position is reached, <ActPos> will be reset to zero. A second motion will start to the Secure Position also stored in OTP. More details are given below.

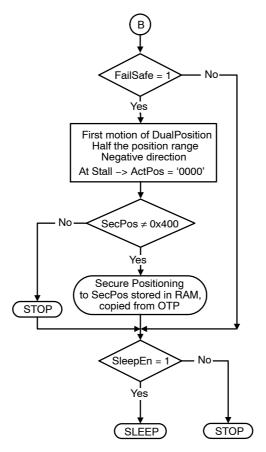


Figure 25. Case B: LIN Lost at or During Start-Up

If LIN is lost before or at power on, following sequence will be followed. See Figure 25.

- If the LIN communication is lost AND
   <FailSafe> = 0, secure positioning will be
   done at absolute position (stored secure position
   <secPos>.) Depending on SleepEn
   AMIS-30623 will enter the <stop> state or
   <sleep> state. See Table 35.
- 2. If the LIN communication is lost AND <FailSafe> = 1 a referencing is started using DualPositioning, meaning a <u>negative</u> motion for half the positioner range is initiated until the stall position is reached. The motion parameters stored in OTP will be used for this. After this mechanical end position is reached <ActPos> will be reset to zero. The direction of the motion is given by the <u>Shaft bit</u>.
  - If <SecPos [ 10:0 ]> = 0x400:
     No Second Motion will be performed.

If <SecPos[10:0]> ≠ 0x400:
 A second motion to <SecPos> is performed.
 The direction is given by <SecPos[10]> in combination with <Shaft>. Motion is done with parameters from OTP.

Depending on SleepEn AMIS-30623 will enter the <Stop> state or <Sleep> state. See Table 35.

#### **Important Remarks:**

- 1. The Secure Position has only a resolution of 9 bit because only the 9 MSB's will be copied from OTP to RAM. See also <u>Secure Position</u>
- 2. The motion direction to SecPos is given by the <u>Shaft bit</u> in OTP.
- 3. In case of HW2 float (= lost LIN address), the behavior is the same as described above, except for going to sleep mode. In that case failsafe operation due to HW2 float is not leading to the sleep state, otherwise the LIN communication will wake-up the node and cycling through POR will occur. See also <u>Hardwired Address HW2</u>.

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### LIN APPLICATION COMMANDS

#### Introduction

The LIN Master will have to use commands to manage the different application tasks the AMIS–30623 can feature. The commands summary is given in Table 37 below.

#### Table 37. COMMANDS SUMMARY

Command			Frames		
Mnemonic	Code	Prep #	Read #	Write #	Description
READING COMMAND					
<u>GetActualPos</u>	0x00	7, 8	5, 6		Returns the actual position of the motor
<u>GetFullStatus</u>	0x01	7, 8	6		Returns a complete status of the circuit
<u>GetOTPparam</u>	0x02	7, 8	6		Returns the OTP memory content
GetStatus	0x03		5		Returns a short status of the circuit
WRITING COMMANDS					
<u>GotoSecurePosition</u>	0x04			1	Drives the motor to its secure position
<u>HardStop</u>	0x05			1	Immediate motor stop
<u>ResetPosition</u>	0x06			1	Actual position becomes the zero position
RunVelocity	0x17			1	Drives motor continuously
<u>SetDualPosition</u>	0x08			4	Drives the motor to 2 different positions with different speed
<u>SetMotorParam</u>	0x09			4	Programs the motion parameters and values for the current in the motor's coils
<u>SetOTPparam</u>	0x10			4	Programs (and zaps) a selected byte of the OTP memory
<u>SetStallparam</u>	0x16			4	Programs the motion detection parameters
<u>SetPosition</u>	0x0B			1, 3, 4	Drives the motor to a given position
<u>SetPositionShort</u> (1 m.)	0x0C			2	Drives the motor to a given position (half step mode only)
<u>SetPositionShort</u> (2 m.)	0x0D			2	Drives two motors to 2 given positions (half step only)
<u>SetPositionShort</u> (4 m.)	0x0E			2	Drives four motors to 4 given positions (half step only)
<u>SetPosParam</u>	0x2F			2	Drives the motor to a given position and programs some of the motion parameters.
SERVICE COMMANDS	•	•		•	•
Sleep				1	Drives circuit into sleep mode if <sleepen> = 1</sleepen>

<u>Sleep</u>			1	Drives circuit into sleep mode if <sleepen> = 1 Drives circuit into stopped mode if if <sleepen> = 0</sleepen></sleepen>
<u>SoftStop</u>	0x0F		1	Motor stopping with a deceleration phase
TestBemf	0x1F		1	Outputs Bemf voltage on pin SWI

These commands are described hereafter, with their corresponding LIN frames. Refer to <u>LIN Frames</u> for more details on LIN frames, particularly for what concerns dynamic assignment of identifiers. A color coding is used to

distinguish between master and slave parts within the frames and to highlight dynamic identifiers. An example is shown below.

		$\overline{}$	Slav	/e in-frame	ng Fran	ne		Dynamic Ide	ntifier
	Master			(white)	) Stru	cture		(from Mas	
Byte	Com	Bit 7	Bit 6	ि रु	Bit 4	Bit 3	Bit 2		Bit 0
0	Identifier	*	*	2	ID4	ID3	ID2 🖊	ID1	ID0
1	Data 1	ESW		Ń		AD[6:0]			
2	Data 2	VddReset	StepLoss	ElDef	UV2	UV1	TSD	TW	Tinfo[1:0]

#### Figure 26. Color Code Used in the Definition of LIN Frames

Usually, the AMIS–30623 makes use of dynamic identifiers for general–purpose 2, 4 or 8 bytes writing frames. If dynamic identifiers are used for other purposes, this is acknowledged.

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Some frames implement a <Broad> bit that allows addressing a command to all the AMIS-30623 circuits connected to the same LIN bus. <Broad> is active when at '0', in which case the physical address provided in the frame is thus not taken into account by the slave nodes.

#### **Application Commands**

#### GetActualPos

This command is provided to the circuit by the LIN master to get the actual position of the stepping-motor. This

GetActualPos corresponds to the following LIN reading frames.

1. four data bytes in-frame response with direct ID (type #5)

position (<ActPos[15:0]>) is returned in signed two's complement 16-bit format. One should note that according to the programmed stepping mode, the LSB's of <ActPos[15:0]> may have no meaning and should be assumed to be '0', as prescribed in <u>Position Ranges</u>. GetActualPos also provides a quick status of the circuit and the stepper-motor, identical to that obtained by command <u>GetStatus</u> (see further).

**Note:** A GetActualPos command will not attempt to reset any flag.

			Structure								
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
0	Identifier	*	*	1	0	ID3	ID2	ID1	ID0		
1	Data 1	ESW AD[6:0]									
2	Data 2				ActPos	s[15:8]					
3	Data 3				ActPo	s[7:0]					
4	Data 4	VddReset	VddReset StepLoss ElDef UV2 TSD TW Tinfo[1:0]								
5	Checksum	Checksum over data									

#### Table 38. READING FRAME TYPE #5

Where:

(\*) According to parity computation

ID[5:0]: Dynamically allocated direct identifier. There should be as many dedicated identifiers to this GetActualPos command as there are stepper-motors connected to the LIN bus.

Note: Bit 5 and bit 4 in byte 0 indicate the number of data bytes.

2. The master sends either a type#7 or type#8 preparing frame. After the type#7 or #8 preparing frame, the master sends a reading frame type#6 to retrieve the circuit's in-frame response.

Table 39. GetActualPos PREPARING FRAME TYPE #7

			Structure									
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0			
0	Identifier	*	*	0	ID4	ID3	ID2	ID1	ID0			
1	Data 1	1		CMD[6:0] = 0x00								
2	Data 2	1		AD[6:0]								
3	Checksum				Che	ecksum over d	ata					

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### Table 40. GetActualPos PREPARING FRAME TYPE #6

					Strue	cture				
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier	0	1	1	1	1	1	0	1	
1	Data 1	ESW	ESW AD[6:0]							
2	Data 2		ActPos[15:8]							
3	Data 3		ActPos[7:0]							
4	Data 4	VddReset	StepLoss	ElDef	UV2	TSD	TW	Tinfo	[1:0]	
5	Data 5				0x	FF				
6	Data 6				0x	FF				
7	Data 7				0x	FF				
8	Data 8		0xFF							
9	Checksum				Checksum	over data				

Where:

(\*) According to parity computation

#### Table 41. GetActualPos PREPARING FRAME TYPE #8

					Strue	cture						
Byte	Content	Bit 7	Bit 7         Bit 6         Bit 5         Bit 4         Bit 3         Bit 2         Bit 1         Bit									
0	Identifier	0	0 0 1 1 1 1 0 0									
1	Data 1		AppCMD =80									
2	Data 2	1	1 CMD[6:0] = 0x00									
3	Data 3	1	1 AD[6:0]									
4	Data 4				Data4[	7:0] FF						
5	Data 5				Data5[	7:0] FF						
6	Data 6				Data6[	7:0] FF						
7	Data 7		Data7[7:0] FF									
8	Data 8		Data8[7:0] FF									
9	Checksum				Checksum	n over data						

#### Table 42. GetActualPos READING FRAME TYPE #6

					Struc	cture				
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier	0	1	1	1	1	1	0	1	
1	Data 1	ESW	ESW AD[6:0]							
2	Data 2		ActPos[15:8]							
3	Data 3		ActPos[7:0]							
4	Data 4	VddReset	StepLoss	ElDef	UV2	TSD	TW	Tinfo	[1:0]	
5	Data 5				0xl	FF				
6	Data 6				0xl	FF				
7	Data 7		0xFF							
8	Data 8				0xl	FF				
9	Checksum				Checksum	over data				

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### GetFullStatus

This command is provided to the circuit by the LIN master to get a complete status of the circuit and the stepper-motor. Refer to <u>RAM Registers</u> and <u>Flags Table</u> to see the meaning of the parameters sent to the LIN master.

Note: A GetFullStatus command will attempt to reset flags <TW>, <TSD>, <UV2>, <ElDef>, <StepLoss>, <CPFail>, <OVC1>, <OVC2>, <VddReset>, <Stall>, <AbsStall>, <DelStallLo> and <DelStallHi>.

Table 43. GetFullStatus PREPARING FRAME TYPE #7

The master sends either type#7 or type#8 preparing frame. GetFullStatus corresponds to 2 <u>successive</u> LIN in-frame responses with **0x3D** indirect ID.

**Note:** It is not mandatory for the LIN master to initiate the second in–frame response if the data in the second response frame is not needed by the application.

1. The master sends a type #7 preparing frame. After the type#7 preparing frame, the master sends a reading frame type#6 to retrieve the circuit's in-frame response.

			Structure								
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
0	Identifier	*	*	0	ID4	ID3	ID2	ID1	ID0		
1	Data 1	1		CMD[6:0] = 0x01							
2	Data 2	1				AD[6:0]					
3	Checksum				Che	ecksum over	data				

			Structure									
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0			
0	Identifier	0	1	1	1	1	1	0	1			
1	Data 1	1	1 AD[6:0]									
2	Data 2		Irun[3:0] Ihold[3:0]									
3	Data 3		Vmax	[3:0]			Vr	nin[3:0]				
4	Data 4	AccShape	StepMo	ode[1:0]	Shaft	Acc[3:0]						
5	Data 5	VddReset	StepLoss	ElDef	UV2	TSD	TW	Tinfo	[1:0]			
6	Data 6		Motion[2:0]		ESW	OVC1	OVC2	Stall	CPFail			
7	Data 7	1	1	1	1	TimeE	DataE	HeadE	BitE			
8	Data 8	AbsThr[3:0] DelThr[3:0]							•			
9	Checksum				Checksum	over data						

#### Table 45. GetFullStatus READING FRAME TYPE #6 (2)

					Struc	ture			
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Identifier	0	1	1	1	1	1	0	1
1	Data 1	1	1 AD[6:0]						
2	Data 2		ActPos[15:8]						
3	Data 3		ActPos[7:0]						
4	Data 4				TagPos	[15:8]			
5	Data 5				TagPos	s[7:0]			
6	Data 6				SecPo	s[7:0]			
7	Data 7	FS2StallEn[2:0] 1 DC100 SecPos[10:8]							
8	Data 8	AbsStall	DelStallLo	DelStallHi	i MinSamples[2:0] DC100StEn PV				PWMJEn
9	Checksum	Checksum over data							

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Where:

(\*) According to parity computation

2. The master sends a type #8 preparing frame. After the type#8 preparing frame, the master sends a reading frame type#6 to retrieve the circuit's in-frame response.

			Structure							
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier	0	0	1	1	1	1	0	0	
1	Data 1		AppCMD =80							
2	Data 2	1	1 CMD[6:0] = 0x01							
3	Data 3	1 AD[6:0]								
4	Data 4		Data4[7:0] FF							
5	Data 5				Data5[7:	:0] FF				
6	Data 6				Data6[7:	:0] FF				
7	Data 7		Data7[7:0] FF							
8	Data 8	Data8[7:0] FF								
9	Checksum		Checksum over data							

#### Table 46. GetFullStatus PREPARING FRAME TYPE#8

#### Table 47. GetFullStatus READING FRAME TYPE #6 (1)

			Structure							
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier	0	1	1	1	1	1	0	1	
1	Data 1	1	AD[6:0]							
2	Data 2		Irun[3:0] Ihold[3:0]							
3	Data 3		Vmax[	3:0]		Vmin[3:0]				
4	Data 4	AccShape	StepMo	de[1:0]	Shaft		Acc[3	3:0]		
5	Data 5	VddReset	StepLoss	ElDef	UV2	TSD	TW	Tinfo	[1:0]	
6	Data 6		Motion[2:0]		ESW	OVC1	OVC2	Stall	CPFail	
7	Data 7	1	1 1 1 1				DataE	HeadE	BitE	
8	Data 8		AbsThr	[3:0]		DelThr[3:0]				
6	Checksum	Checksum over data								

#### Table 48. GetFullStatus READING FRAME TYPE #6 (2)

			Structure								
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
0	Identifier	0	1	1	1	1	1	0	1		
1	Data 1	1	1 AD[6:0]								
2	Data 2		ActPos[15:8]								
3	Data 3		ActPos[7:0]								
4	Data 4				TagPo	s[15:8]					
5	Data 5				TagPo	os[7:0]					
6	Data 6				SecPo	os[7:0]					
7	Data 7	FS2StallEn[2:0] 1 DC100 SecPos[10:8]									
8	Data 8	AbsStall	DelStallLo	DelStallHi	MinSamples[2:0] DC100StEn F			PWMJEn			
9	Checksum	Checksum over data									

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#### GetOTPparam

This command is provided to the circuit by the LIN master after a preparing frame (see <u>Preparing frames</u>), to read the

content of an OTP memory segment which address was specified in the preparation frame.

GetOTPparam corresponds to a LIN in-frame response with **0x3D** indirect ID.

1. The master sends a type #7 preparing frame. After the type#7 preparing frame, the master sends a reading frame type#6 to retrieve the circuit's in-frame response.

#### Table 49. GetOTPparam PREPARING FRAME TYPE #7

			Structure							
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier	*	* 0 ID4 ID3 ID2 ID1 ID0						ID0	
1	Data 1	1	CMD[6:0] = 0x02							
2	Data 2	1	AD[6:0]							
3	Checksum		Checksum over data							

#### Table 50. GetOTPparam READING FRAME TYPE #6

			Structure								
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
0	Identifier	0	1	1	1	1	1	0	1		
1	Data 1		OTP byte @0x00								
2	Data 2		OTP byte @0x01								
3	Data 3		OTP byte @0x02								
4	Data 4				OTP byte	e @0x03					
5	Data 5				OTP byte	e @0x04					
6	Data 6				OTP byte	e @0x05					
7	Data 7	OTP byte @0x06									
8	Data 8	OTP byte @0x07									
9	Checksum	Checksum over data									

Where:

(\*) According to parity computation

2.) The master sends a type #8 preparing frame. After the type#8 preparing frame, the master sends a reading frame type#6 to retrieve the circuit's in-frame response.

Table 51. GetOTPparam PREPARING FRAME TYPE #8

			Structure							
Byte	Content	Bit 7	Bit 6         Bit 5         Bit 4         Bit 3         Bit 2         Bit 1         Bit 3							
0	Identifier	0	0	1	1	1	1	0	0	
1	Data 1		AppCMD =80							
2	Data 2	1	1 CMD[6:0] = 0x02							
3	Data 3	1	1 AD[6:0]							
4	Data 4		Data4[7:0] FF							
5	Data 5				Data5[	7:0] FF				
6	Data 6				Data6[	7:0] FF				
7	Data 7	Data7[7:0] FF								
8	Data 8	Data8[7:0] FF								
9	Checksum		Checksum over data							

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			Structure							
Byte	Content	Bit 7	Bit 7         Bit 6         Bit 5         Bit 4         Bit 3         Bit 2         Bit 1         Bit 3							
0	Identifier	0	1	1	1	1	1	0	1	
1	Data 1		OTP byte @0x00							
2	Data 2		OTP byte @0x01							
3	Data 3		OTP byte @0x02							
4	Data 4		OTP byte @0x03							
5	Data 5				OTP byte	e @0x04				
6	Data 6				OTP byte	e @0x05				
7	Data 7		OTP byte @0x06							
8	Data 8	OTP byte @0x07								
9	Checksum	Checksum over data								

#### Table 52. GetOTPparam READING FRAME TYPE #6

#### GetStatus

This command is provided to the circuit by the LIN master to get a quick status (compared to that of <u>GetFullStatus</u> command) of the circuit and of the stepper-motor. Refer to <u>Flags Table</u> to see the meaning of the parameters sent to the LIN master. Note: A GetStatus command will attempt to reset flags <TW>, <TSD>, <UV2>, <ElDef>, <StepLoss> and <VddReset>.

GetStatus corresponds to a 2 data bytes LIN in-frame response with a direct ID (type #5).

Table 53. GetStatus READI	NG FRAME TYPE #5
---------------------------	------------------

		Structure								
Byte	Content	Bit 7	Bit 6	Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0						
0	Identifier	*	*	0	ID4	ID3	ID2	ID1	ID0	
1	Data 1	ESW	AD[6:0]							
2	Data 2	VddReset	StepLoss ElDef UV2 TSD TW Tinfo[1:0]							
3	Checksum		Checksum over data							

Where:

(\*) According to parity computation

ID[5:0]: Dynamically allocated direct identifier. There should be as many dedicated identifiers to this GetStatus command as there are stepper–motors connected to the LIN bus.

#### GotoSecurePosition

This command is provided by the LIN master to one or all of the stepper-motors to move to the secure position <SecPos[10:0]>. It can also be internally triggered if the LIN bus communication is lost, after an initialization phase, or prior to going into sleep mode. See the <u>priority</u> <u>encoder</u> description for more details. The priority encoder table also acknowledges the cases where a GotoSecurePosition command will be ignored.

**Note:** The dynamic ID allocation has to be assigned to 'General Purpose 2 Data bytes' ROM pointer, i.e. '0000'. The command is decoded only from the command data.

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GotoSecurePosition corresponds to the following LIN writing frame (type #1).

			Structure						
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Identifier	*	* 0 ID4 ID3 ID2 ID1 ID0						ID0
1	Data	1	CMD[6:0] = 0x04						
2	Data	Broad	AD[6:0]						
3	Checksum		Checksum over data						

Table 54. GotoSecurePosition WRITING FRAME TYPE #1

Where:

(\*) according to parity computation

Broad: If Broad = '0' all the stepper motors connected to the LIN bus will reach their secure position

#### HardStop

This command will be internally triggered when an electrical problem is detected in one or both coils, leading to shutdown mode. If this occurs while the motor is moving, the <StepLoss> flag is raised to allow warning of the LIN master at the next <u>GetStatus</u> command that steps may have been lost. Once the motor is stopped, <ActPos> register is copied into <TagPos> register to ensure keeping the stop position.

**Note:** The dynamic ID allocation has to be assigned to 'General Purpose 2 Data bytes' ROM pointer, i.e. '0000'. The command is decoded only from the command data.

A hardstop command can also be issued by the LIN master for some safety reasons. It corresponds then to the following two data bytes LIN writing frame (type #1).

lable 55. I	HardStop	WRITING	FRAME	IYPE #1

			Structure									
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0			
0	Identifier	*	*	ID5	ID4	ID3	ID2	ID1	ID0			
1	Data	1		CMD[6:0] = 0x05								
2	Data	Broad		AD[6:0]								
3	Checksum				Che	ecksum over d	ata					

Where:

(\*) according to parity computation

\_\_\_\_.

Broad: If broad = '0' all stepper motors connected to the LIN bus will stop

#### ResetPosition

This command is provided to the circuit by the LIN master to reset <ActPos> and <TagPos> registers to zero. This can be helpful to prepare for instance a relative positioning. The reset position command sets the internal flag "Reference done". **Note:** The dynamic ID allocation has to be assigned to 'General Purpose 2 Data bytes' ROM pointer, i.e. '0000'. The command is decoded only from the command data.

ResetPosition corresponds to the following LIN writing frames (type #1).

#### Table 56. ResetPosition WRITING FRAME TYPE #1

			Structure							
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier	*	*	ID5	ID4	ID3	ID2	ID1	ID0	
1	Data	1			С	MD[6:0] = 0x0	6			
2	Data	Broad				AD[6:0]				
3	Checksum				Che	ecksum over d	lata			

Where:

(\*) according to parity computation

Broad: If broad = '0' all the circuits connected to the LIN bus will reset their <ActPos> and <TagPos> registers

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#### **RunVelocity**

This command is provided to the circuit by the LIN Master in order to put the motor in continuous motion state. Note: in this mode (RunVelocity), the shaft bit has no impact on the direction of movement.

**Note:** The dynamic ID allocation has to be assigned to 'General Purpose 2 Data bytes' ROM pointer, i.e. '0000'. The command is decoded only from the command data.

**Note:** Continuous LIN communication is required. If not, Lost–LIN is detected and an autonomous motion will start. See also <u>LIN lost behavior</u>.

RunVelocity corresponds to the following LIN writing frames (type #1).

#### Table 57. RunVelocity WRITING FRAME TYPE #1

			Structure								
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
0	Identifier	*	*	ID5	ID4	ID3	ID2	ID1	ID0		
1	Data 1	1		CMD[6:0] = 0x17							
2	Data 2	Broad				AD[6:0]					
3	Checksum			Checksum over data							

Where:

(\*) according to parity computation

Broad: If broad = '0' all the stepper motors connected to the LIN bus will start continuous motion.

#### **SetDualPosition**

This command is provided to the circuit by the LIN master in order to perform a positioning of the motor using two different velocities. See <u>Dual Positioning</u>. After Dual positioning the internal flag "Reference done" is set. **Note:** This sequence cannot be interrupted by another positioning command.

SetDualPosition corresponds to the following LIN writing frame with 0x3C identifier (type #4).

#### Table 58. SetDualPositioning WRITING FRAME TYPE #4

			Structure									
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0			
0	Identifier	0	0	1	1	1	1	0	0			
1	Data 1		AppCMD = 0x80									
2	Data 2	1	1 CMD[6:0] = 0x08									
3	Data 3	Broad	road AD[6:0]									
4	Data 4		Vma	x[3:0]			Vmir	า[3:0]				
5	Data 5				Pos1	[15:8]						
6	Data 6				Post	[7:0]						
7	Data 7				Pos2	[15:8]						
8	Data 8				Pos	2[7:0]						
9	Checksum				Checksum	n over data						

Where:

Broad: If broad = '0' all the circuits connected to the LIN bus will run the dual positioning

Vmax[3:0]: Max velocity for first motion

Vmin[3:0]: Min velocity for first motion and velocity for the second motion

Pos1[15:0]: First position to be reached during the first motion

Pos2[15:0]: Relative position of the second motion

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#### SetStallParam

This command sets the motion detection parameters and the related stepper-motor parameters, such as the minimum and maximum velocity, the run and hold current, acceleration and step mode. See <u>Motion detection</u> for the meaning of the parameters sent by the LIN Master.

SetStallParam corresponds to a 0x3C LIN command (type #4).

Table 59. SetStallParam	WRITING FRAME TYPE #4
-------------------------	-----------------------

					Stru	ucture				
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier	0	0	0 1 1 1 1 0 0						
1	Data 1		AppCMD = 0x80							
2	Data 2	1	CMD[6:0] = 0x16							
3	Data 3	Broad	AD[6:0]							
4	Data 4		Iru	า[3:0]			lh	old[3:0]		
5	Data 5		Vma	ax[3:0]			Vr	nin[3:0]		
6	Data 6	Mi	nSamples[2:	0]	Shaft		A	cc[3:0]		
7	Data 7		AbsT	<sup>-</sup> hr[3:0]			De	IThr[3:0]		
8	Data 8	F	S2StallEn[2:0] AccShape StepMode[1:0] DC100StEn PWMJE						PWMJEn	
9	Checksum				Checksur	m over data				

Where:

Broad: If Broad = '0' all the circuits connected to the LIN bus will set the parameters in their RAMs as requested

#### SetMotorParam

This command is provided to the circuit by the LIN master to set the values for the stepper motor parameters (listed below) in RAM. Refer to <u>RAM Registers</u> to see the meaning of the parameters sent by the LIN master.

**Important:** If a SetMotorParam occurs while a motion is ongoing, it will modify at once the motion parameters (see

<u>Position Controller</u>). Therefore the application should not change other parameters than <Vmax> and <Vmin> while a motion is running, otherwise correct positioning cannot be guaranteed.

SetMotorParam corresponds to the following LIN writing frame with 0x3C identifier (type #4).

Table 60. SetMotorParam	WRITING FRAME TYPE #4
-------------------------	-----------------------

					Struct	ture				
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier	0	0	1	1	1	1	0	0	
1	Data 1		AppCMD = 0x80							
2	Data 2	1	CMD[6:0] = 0x09							
3	Data 3	Broad	road AD[6:0]							
4	Data 4		Irur	n[3:0]			lhold	l[3:0]		
5	Data 5		Vma	ax[3:0]			Vmir	n[3:0]		
6	Data 6		SecPos[10:8]		Shaft		Acc	[3:0]		
7	Data 7				SecPos	s[7:0]				
8	Data 8	1	PWMfreq	1	AccShape	StepMode[1:0] 1 PWMJEn				
9	Checksum				Checksum	over data		•		

Where:

Broad: If Broad = '0' all the circuits connected to the LIN bus will set the parameters in their RAMs as requested

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#### SetOTPparam

This command is provided to the circuit by the LIN master to program the content D[7:0] of the OTP memory byte OTPA[2:0] and to zap it.

**Important:** This command must be sent under a specific  $V_{BB}$  voltage value. See parameter VBBOTP in <u>DC</u> <u>Parameters</u>. This is a mandatory condition to ensure reliable zapping.

SetMotorParam corresponds to a 0x3C LIN writing frames (type #4).

					Struc	cture				
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier	0	0	1	1	1	1	0	0	
1	Data 1		AppCMD = 0x80							
2	Data 2	1			C	MD[6:0] = 0x1	0			
3	Data 3	Broad		AD[6:0]						
4	Data 4	1	1	1	1	1		OTPA[2:0]		
5	Data 5				D[7	':0]				
6	Data 6				0xl	FF				
7	Data 7				0xl	FF				
8	Data 8		0xFF							
9	Checksum				Checksum	over data				

Where:

Broad: If Broad = '0' all the circuits connected to the LIN bus will set the parameters in their OTP memories as requested

#### SetPosition

This command is provided to the circuit by the LIN master to drive one or two motors to a given absolute position. See <u>Positioning</u> for more details. The priority encoder table (See <u>Priority Encoder</u>) describes the cases where a SetPosition command will be ignored.

SetPosition corresponds to the following LIN write frames.

1. Two (2) Data bytes frame with a direct ID (type #3)

#### Table 62. SetPosition WRITING FRAME TYPE #3

			Structure									
Byte	Content	Bit 7	Bit 7         Bit 6         Bit 5         Bit 4         Bit 3         Bit 2         Bit 1         Bit 0									
0	Identifier	*	* * 0 ID4 ID3 ID2 ID1 II									
1	Data 1				Pos[	15 :8]						
2	Data 2		Pos[7 :0]									
3	Checksum				Checksum	n over data						

Where:

(\*) According to parity computation

ID[5:0]: Dynamically allocated direct identifier. There should be as many dedicated identifiers to this SetPosition command as there are stepper–motors connected to the LIN bus.

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2. Four (4) Data bytes frame with general purpose identifier (type #1).

Note: The dynamic ID allocation has to be assigned to 'General Purpose 4 Data bytes' ROM pointer, i.e. '0001'.

#### Table 63. SetPosition WRITING FRAME TYPE #1

			Structure									
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0			
0	Identifier	*	*	1	0	ID3	ID2	ID1	ID0			
1	Data 1	1	CMD[6:0] = 0x0B									
2	Data 2	Broad			AD[	[6:0]						
3	Data 3				Pos[	15:8]						
4	Data 4		Pos[7:0]									
5	Checksum				Checksum	n over data						

Where:

(\*) According to parity computation

Broad: If broad = '0' all the stepper motors connected to the LIN will must go to Pos [15:0].

3. Two (2) motors positioning frame with **0x3C** identifier (type #4)

Table 64. SetPosition WRITING FRAME TYPE #4

		Structure									
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
0	Identifier	0	0	1	1	1	1	0	0		
1	Data 1		AppCMD = 0x80								
2	Data 2	1	1 CMD[6:0] = 0x0B								
3	Data 3	1 AD1[6:0]									
4	Data 4				Pos1	[15:8]					
5	Data 5				Pos1	[7:0]					
6	Data 6	1			AD2	[6:0]					
7	Data 7		Pos2[15:8]								
8	Data 8	Pos2[7:0]									
9	Checksum				Checksum	ı over data					

Where:

Adn[6:0] : Motor #n physical address ( $n \in [1,2]$ ).

Posn[15:0] : Signed 16-bit position set-point for motor #n.

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#### SetPositionShort

This command is provided to the circuit by the LIN Master to drive one, two or four motors to a given absolute position. It applies only for half stepping mode (StepMode[1:0] = "00") and is ignored when in other stepping modes. See <u>Positioning</u> for more details.

The physical address is coded on 4 bits, hence SetPositionShort can only be used with a network implementing a maximum of 16 slave nodes. These 4 bits are corresponding to the bits PA[3:0] in OTP memory (address 0x02) See <u>Physical Address of the Circuit</u>. For SetPositionShort it is recommended to set HW0, HW1 and HW2 to '1'.

The priority encoder table (See <u>Priority Encoder</u>) describes the cases where a SetPositionShort command will be ignored.

SetPositionShort corresponds to the following LIN writing frames:

1. Two (2) data bytes frame for one (1) motor, with specific identifier (type #2)

#### Table 65. SetPositionShort WRITING FRAME TYPE #2

		Structure								
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier	*	*	0	ID4	ID3	ID2	ID1	ID0	
1	Data 1		Pos[10:8]		Broad	AD [3:0]				
2	Data 2		Pos [7:0]							
3	Checksum		Checksum over data							

Where:

(\*) According to parity computation

Broad: If broad = '0' all the stepper motors connected to the LIN bus will go to Pos [10:0]. ID[5:0]: Dynamically allocated identifier to two data bytes SetPositionShort command.

\_\_\_\_\_\_

2. Four (4) data bytes frame for two (2) motors, with specific identifier (type # 2)

#### Table 66. SetPositionShort WRITING FRAME TYPE #2

		Structure								
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier	* * 1			0	ID3	ID2	ID1	ID0	
1	Data 1	Pos1[10:8]			1	AD1[3:0]				
2	Data 2		Pos1[7:0]							
3	Data 3		Pos2[10:8]		1	AD2[3:0]				
4	Data 4	Pos2[7:0]								
5	Checksum				Checksum	n over data				

Where:

(\*) according to parity computation

ID[5:0]: Dynamically allocated identifier to four data bytes SetPositionShort command.

Adn[3:0]: Motor #n physical address least significant bits ( $n \in [1,2]$ ).

Posn[10:0]: Signed 11-bit position set point for Motor #n (see RAM Registers)

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3. Eight (8) data bytes frame for four (4) motors, with specific identifier (type #2)

			Structure								
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
0	Identifier	*	*	1	1	ID3	ID2	ID1	ID0		
1	Data 1		Pos1[10:8]		1	AD1[3:0]					
2	Data 2		Pos1[7:0]								
3	Data 3		Pos2[10:8]		1	AD2[3:0]					
4	Data 4				Pos2	2[7:0]					
5	Data 5		Pos3[10:8]		1	AD3[3:0]					
6	Data 6				Posa	8[7:0]					
7	Data 7	Pos4[10:8]			1	AD4[3:0]					
8	Data 8		Pos4[7:0]								
9	Checksum				Checksum	over data					

Table 67. SetPositionShort WRITING FRAME TYPE #2

Where:

(\*) according to parity computation

ID[5:0]: Dynamically allocated identifier to eight data bytes SetPositionShort command.

Adn[3:0]: Motor #n physical address least significant bits ( $n \in [1,4]$ ).

Posn[10:0]: Signed 11-bit position set point for Motor #n (see RAM Registers)

#### SetPosParam

This command is provided to the circuit by the LIN Master to drive one motor to a given absolute position.

It also sets some of the values for the stepper motor parameters such as minimum and maximum velocity.

SetPosParam corresponds to a four (4) data bytes writing LIN frame with specific dynamically assigned identifier (type # 2).

		Structure								
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier	*	*	1	0	ID3	ID2	ID5	ID4	
1	Data 1	Pos[15:8]								
2	Data 2				Pos	[7:0]				
3	Data 3		Vma	x[3:0]		Vmin[3:0]				
4	Data 4		AbsTl	nr[3:0]		Acc[3:0]				
5	Checksum				Checksum	n over data				

Where:

(\*) according to parity computation

Broad: If broad = '0' all the stepper motors connected to the LIN bus will stop with deceleration.

ID[5:0]: Dynamically allocated direct identifier to 4 Data bytes SetPosParam command. There should be as many dedicated identifiers to this SetPosParam command as there are stepper-motors connected to the LIN bus. Pos [15:0]: Signed 16-bit position set-point.

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#### Sleep

This command is provided to the circuit by the LIN master to put all the slave nodes connected to the LIN bus into sleep mode. If this command occurs during a motion of the motor, TagPos is reprogrammed to SecPos (provided SecPos is different from "100 0000 0000"), or a SoftStop is executed before going to sleep mode. See LIN 1.3 specification and <u>Sleep Mode</u>. The corresponding LIN frame is a master request command frame (identifier 0x3C) with data byte 1 containing 0x00 while the followings contain 0xFF.

**Note:** SleepEnable needs to be set to 1 in order to allow the device to go to sleep. If SleepEnable is 0 the device will go into "stopped state"

			Structure							
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier	0	0	1	1	1	1	0	0	
1	Data 1				0x	00				
2	Data 2	0xFF								
3	Checksum				Checksum	n over data				

#### Table 69. SLEEP WRITING FRAME

#### SoftStop

If a SoftStop command occurs during a motion of the stepper motor, it provokes an immediate deceleration to Vmin (see <u>Minimum Velocity</u>) followed by a stop, regardless of the position reached. Once the motor is stopped, TagPos register is overwritten with value in ActPos register to ensure keeping the stop position.

**Note:** The dynamic ID allocation has to be assigned to 'General Purpose 2 Data bytes' ROM pointer '0000'. The command is decoded only from the command data.

**Note:** A SoftStop command occurring during a DualPosition sequence is not taken into account.

Command SoftStop occurs in the following cases:

- The chip temperature rises above the thermal shutdown threshold (see <u>DC Parameters</u> and <u>Temperature</u> <u>Management</u>);
- The LIN master requests a SoftStop. Hence SoftStop will correspond to the following two data bytes LIN writing frame (type #1).

#### Table 70. SoftStop WRITING FRAME TYPE #1

		Structure								
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier	*	*	0	ID4	ID3	ID2	ID1	ID0	
1	Data 1	1	CMD[6:0] = 0x0F							
2	Data 2	Broad	AD[6:0]							
3	Checksum		Checksum over data							

Where:

(\*) according to parity computation

Broad: If broad = '0' all the stepper motors connected to the LIN bus will stop with deceleration.

TestBemf (not applicable for "Product Versions PGA & PNA")

This command is provided to the circuit by the LIN Master in order to output the Bemf integrator output to the SWI output of the chip. Once activated, it can be stopped only after POR. During the Bemf observation, reading of the SWI state is internally forbidden.

**Note:** The dynamic ID allocation has to be assigned to 'General Purpose 2 Data bytes' ROM pointer, i.e. '0000'. The command is decoded only from the command data.

TestBemf corresponds to the following LIN writing frames (type #1).

#### Table 71. TestBemf WRITING FRAME

			Structure							
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0	Identifier	*	*	0	ID4	ID3	ID2	ID1	ID0	
1	Data 1	1			С	MD[6:0] = 0x1	F			
2	Data 2	Broad	d AD[6:0]							
3	Checksum		Checksum over data							

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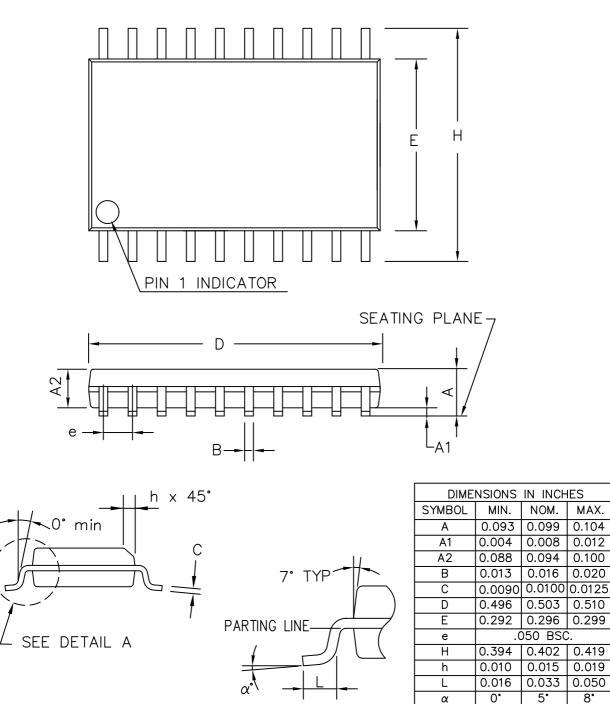
Where:

(\*) according to parity computation

Broad: If broad = '0' all the stepper motors connected to the LIN bus will be affected.

#### PACKAGE DIMENSIONS

SOIC 20 W CASE 751AQ-01 ISSUE O

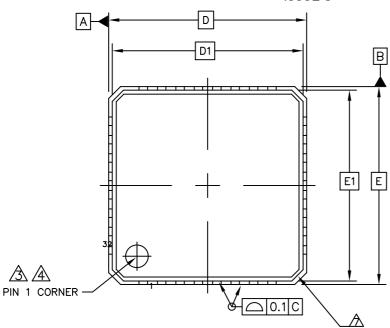


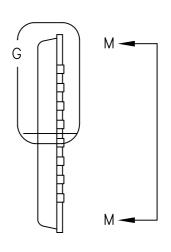
# www.BDhtp://chsemil.com scom/ON/

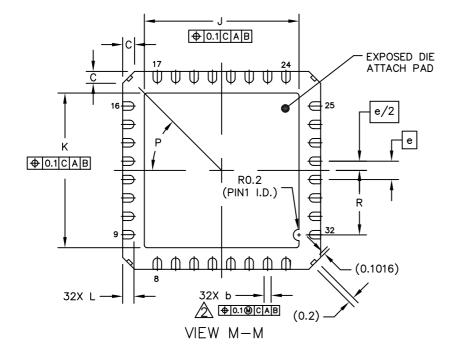
DETAIL A

#### PACKAGE DIMENSIONS

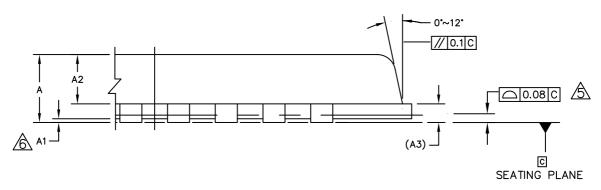
NQFP-32, 7x7 CASE 560AA-01 ISSUE O







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DETAIL G VIEW ROTATED 90° CLOCKWISE

DIM	MIN N	OM MAX		NOTES				
Α	0.8	0.9	1. DIE THICKNES	SS ALLLOWABLE IS 0.305r	mm MAXIMUM			
A1	0 0	.02 0.05	(.012 INCHES	MAXIMUM)				
A2	0.576 0.	615 0.654	$\triangle$ dimension applies to plated terminal and is measured					
A3	0.20	3 REF.		0.2 AND 0.25mm FROM TERMINAL TIP.				
b	0.25 (	0.3 0.35		A THE PIN #1 IDENTIFIER MUST BE PLACED ON THE TOP				
C	0.24 0	.42 0.6	SURFACE OF THE PACKAGE BY USING INDENTATION MARK					
D	7	BSC	OR OTHER FEATURE OF PACKAGE BODY.					
D1	6.75	5 BSC	A EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.					
E	7	BSC						
E1	6.75	5 BSC		ED FOR EXPOSED PAD AND TERMINALS. EXCLUDE DDING PART OF EXPOSED PAD FROM MEASURING.				
e	0.65	5 BSC						
J	5.37 5	.47 5.57	APPLIED ON	LY TO TERMINALS.				
K	5.37 5	.47 5.57	A EXACT SHAF	PE OF EACH CORNER IS (	OPTIONAL.			
L	0.35 (	0.4 0.45						
P	45	REF						
R	2.185	2.385	UNIT	TOLERANCES	REFERENCE DOCUMENT			
			ММ	ASME_Y14.5M	JEDEC-MO-220_REV.F			

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